HP ProLiant MicroServer Gen8 Maintenance and Service Guide

Abstract

This document is for an experienced service technician. It is helpful if you are qualified in the servicing of computer equipment and trained in recognizing hazards in products with hazardous energy levels and are familiar with weight and stability precautions.

Contents

Customer self repair

HP products are designed with many Customer Self Repair (CSR) parts to minimize repair time and allow for greater flexibility in performing defective parts replacement. If during the diagnosis period HP (or HP service providers or service partners) identifies that the repair can be accomplished by the use of a CSR part, HP will ship that part directly to you for replacement. There are two categories of CSR parts:

- **Mandatory**—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

- **Optional**—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

NOTE: Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

Based on availability and where geography permits, CSR parts will be shipped for next business day delivery. Same day or four-hour delivery may be offered at an additional charge where geography permits. If assistance is required, you can call the HP Technical Support Center and a technician will help you over the telephone. HP specifies in the materials shipped with a replacement CSR part whether a defective part must be returned to HP. In cases where it is required to return the defective part to HP, you must ship the defective part back to HP within a defined period of time, normally five (5) business days. The defective part must be returned with the associated documentation in the provided shipping material. Failure to return the defective part may result in HP billing you for the replacement. With a customer self repair, HP will pay all shipping and part return costs and determine the courier/carrier to be used.

For more information about HP's Customer Self Repair program, contact your local service provider. For the North American program, refer to the HP website (http://www.hp.com/go/selfrepair).

Parts only warranty service

Your HP Limited Warranty may include a parts only warranty service. Under the terms of parts only warranty service, HP will provide replacement parts free of charge.

For parts only warranty service, CSR part replacement is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

Réparation par le client (CSR)

Les produits HP comportent de nombreuses pièces CSR (Customer Self Repair = réparation par le client) afin de minimiser les délais de réparation et faciliter le remplacement des pièces défectueuses. Si pendant la période de diagnostic, HP (ou ses partenaires ou mainteneurs agréés) détermine que la réparation peut être effectuée à l'aide d'une pièce CSR, HP vous l'envoie directement. Il existe deux catégories de pièces CSR:

Obligatoire - Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Facultatif - Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

REMARQUE: Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

Les pièces CSR sont livrées le jour ouvré suivant, dans la limite des stocks disponibles et selon votre situation géographique. Si votre situation géographique le permet et que vous demandez une livraison le jour même ou dans les 4 heures, celle-ci vous sera facturée. Pour bénéficier d'une assistance téléphonique, appelez le Centre d'assistance technique HP. Dans les documents envoyés avec la pièce de rechange CSR, HP précise s'il est nécessaire de lui retourner la pièce défectueuse. Si c'est le cas, vous devez le faire dans le délai indiqué, généralement cinq (5) jours ouvrés. La pièce et sa documentation doivent être retournées dans l'emballage fourni. Si vous ne retournez pas la pièce défectueuse, HP se réserve le droit de vous facturer les coûts de remplacement. Dans le cas d'une pièce CSR, HP supporte l'ensemble des frais d'expédition et de retour, et détermine la société de courses ou le transporteur à utiliser.

Pour plus d'informations sur le programme CSR de HP, contactez votre Mainteneur Agrée local. Pour plus d'informations sur ce programme en Amérique du Nord, consultez le site Web HP (http://www.hp.com/go/selfrepair).

Service de garantie "pièces seules"

Votre garantie limitée HP peut inclure un service de garantie "pièces seules". Dans ce cas, les pièces de rechange fournies par HP ne sont pas facturées.

Dans le cadre de ce service, la réparation des pièces CSR par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Riparazione da parte del cliente

Per abbreviare i tempi di riparazione e garantire una maggiore flessibilità nella sostituzione di parti difettose, i prodotti HP sono realizzati con numerosi componenti che possono essere riparati direttamente dal cliente (CSR, Customer Self Repair). Se in fase di diagnostica HP (o un centro di servizi o di assistenza HP) identifica il guasto come riparabile mediante un ricambio CSR, HP lo spedirà direttamente al cliente per la sostituzione. Vi sono due categorie di parti CSR:

Obbligatorie – Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

Opzionali – Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

NOTA: alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

In base alla disponibilità e alla località geografica, le parti CSR vengono spedite con consegna entro il giorno lavorativo seguente. La consegna nel giorno stesso o entro quattro ore è offerta con un supplemento di costo solo in alcune zone. In caso di necessità si può richiedere l'assistenza telefonica di un addetto del centro di supporto tecnico HP. Nel materiale fornito con una parte di ricambio CSR, HP specifica se il cliente deve restituire dei componenti. Qualora sia richiesta la resa ad HP del componente difettoso, lo si deve spedire ad HP entro un determinato periodo di tempo, generalmente cinque (5) giorni lavorativi. Il componente difettoso deve essere restituito con la documentazione associata nell'imballo di spedizione fornito. La mancata restituzione del componente può comportare la fatturazione del ricambio da parte di HP. Nel caso di riparazione da parte del cliente, HP sostiene tutte le spese di spedizione e resa e sceglie il corriere/vettore da utilizzare.

Per ulteriori informazioni sul programma CSR di HP contattare il centro di assistenza di zona. Per il programma in Nord America fare riferimento al sito Web HP (http://www.hp.com/go/selfrepair).

Servizio di garanzia per i soli componenti

La garanzia limitata HP può includere un servizio di garanzia per i soli componenti. Nei termini di garanzia del servizio per i soli componenti, HP fornirà gratuitamente le parti di ricambio.

Per il servizio di garanzia per i soli componenti è obbligatoria la formula CSR che prevede la riparazione da parte del cliente. Se il cliente invece richiede la sostituzione ad HP, dovrà sostenere le spese di spedizione e di manodopera per il servizio.

Customer Self Repair

HP Produkte enthalten viele CSR-Teile (Customer Self Repair), um Reparaturzeiten zu minimieren und höhere Flexibilität beim Austausch defekter Bauteile zu ermöglichen. Wenn HP (oder ein HP Servicepartner) bei der Diagnose feststellt, dass das Produkt mithilfe eines CSR-Teils repariert werden kann, sendet Ihnen HP dieses Bauteil zum Austausch direkt zu. CSR-Teile werden in zwei Kategorien unterteilt:

Zwingend – Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Optional – Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

HINWEIS: Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No" bzw. „Nein" gekennzeichnet.

CSR-Teile werden abhängig von der Verfügbarkeit und vom Lieferziel am folgenden Geschäftstag geliefert. Für bestimmte Standorte ist eine Lieferung am selben Tag oder innerhalb von vier Stunden gegen einen Aufpreis verfügbar. Wenn Sie Hilfe benötigen, können Sie das HP technische Support Center anrufen und sich von einem Mitarbeiter per Telefon helfen lassen. Den Materialien, die mit einem CSR-Ersatzteil geliefert werden, können Sie entnehmen, ob das defekte Teil an HP zurückgeschickt werden muss. Wenn es erforderlich ist, das defekte Teil an HP zurückzuschicken, müssen Sie dies innerhalb eines vorgegebenen Zeitraums tun, in der Regel innerhalb von fünf (5) Geschäftstagen. Das defekte Teil muss mit der zugehörigen Dokumentation in der Verpackung zurückgeschickt werden, die im Lieferumfang enthalten ist. Wenn Sie das

defekte Teil nicht zurückschicken, kann HP Ihnen das Ersatzteil in Rechnung stellen. Im Falle von Customer Self Repair kommt HP für alle Kosten für die Lieferung und Rücksendung auf und bestimmt den Kurier-/Frachtdienst.

Weitere Informationen über das HP Customer Self Repair Programm erhalten Sie von Ihrem Servicepartner vor Ort. Informationen über das CSR-Programm in Nordamerika finden Sie auf der HP Website unter (http://www.hp.com/go/selfrepair).

Parts-only Warranty Service (Garantieservice ausschließlich für Teile)

Ihre HP Garantie umfasst möglicherweise einen Parts-only Warranty Service (Garantieservice ausschließlich für Teile). Gemäß den Bestimmungen des Parts-only Warranty Service stellt HP Ersatzteile kostenlos zur Verfügung.

Für den Parts-only Warranty Service ist das CSR-Verfahren zwingend vorgegeben. Wenn Sie den Austausch dieser Teile von HP vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Reparaciones del propio cliente

Los productos de HP incluyen muchos componentes que el propio usuario puede reemplazar (*Customer Self Repair*, CSR) para minimizar el tiempo de reparación y ofrecer una mayor flexibilidad a la hora de realizar sustituciones de componentes defectuosos. Si, durante la fase de diagnóstico, HP (o los proveedores o socios de servicio de HP) identifica que una reparación puede llevarse a cabo mediante el uso de un componente CSR, HP le enviará dicho componente directamente para que realice su sustitución. Los componentes CSR se clasifican en dos categorías:

- **Obligatorio:** componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

- **Opcional:** componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

NOTA: Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

Según la disponibilidad y la situación geográfica, los componentes CSR se enviarán para que lleguen a su destino al siguiente día laborable. Si la situación geográfica lo permite, se puede solicitar la entrega en el mismo día o en cuatro horas con un coste adicional. Si precisa asistencia técnica, puede llamar al Centro de asistencia técnica de HP y recibirá ayuda telefónica por parte de un técnico. Con el envío de materiales para la sustitución de componentes CSR, HP especificará si los componentes defectuosos deberán devolverse a HP. En aquellos casos en los que sea necesario devolver algún componente a HP, deberá hacerlo en el periodo de tiempo especificado, normalmente cinco días laborables. Los componentes defectuosos deberán devolverse con toda la documentación relacionada y con el embalaje de envío. Si no

enviara el componente defectuoso requerido, HP podrá cobrarle por el de sustitución. En el caso de todas sustituciones que lleve a cabo el cliente, HP se hará cargo de todos los gastos de envío y devolución de componentes y escogerá la empresa de transporte que se utilice para dicho servicio.

Para obtener más información acerca del programa de Reparaciones del propio cliente de HP, póngase en contacto con su proveedor de servicios local. Si está interesado en el programa para Norteamérica, visite la página web de HP siguiente (http://www.hp.com/go/selfrepair).

Servicio de garantía exclusivo de componentes

La garantía limitada de HP puede que incluya un servicio de garantía exclusivo de componentes. Según las condiciones de este servicio exclusivo de componentes, HP le facilitará los componentes de repuesto sin cargo adicional alguno.

Para este servicio de garantía exclusivo de componentes, es obligatoria la sustitución de componentes por parte del usuario (CSR). Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

Customer Self Repair

Veel onderdelen in HP producten zijn door de klant zelf te repareren, waardoor de reparatieduur tot een minimum beperkt kan blijven en de flexibiliteit in het vervangen van defecte onderdelen groter is. Deze onderdelen worden CSR-onderdelen (Customer Self Repair) genoemd. Als HP (of een HP Service Partner) bij de diagnose vaststelt dat de reparatie kan worden uitgevoerd met een CSR-onderdeel, verzendt HP dat onderdeel rechtstreeks naar u, zodat u het defecte onderdeel daarmee kunt vervangen. Er zijn twee categorieën CSR-onderdelen:

Verplicht: Onderdelen waarvoor reparatie door de klant verplicht is. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

Optioneel: Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

OPMERKING: Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

Afhankelijk van de leverbaarheid en de locatie worden CSR-onderdelen verzonden voor levering op de eerstvolgende werkdag. Levering op dezelfde dag of binnen vier uur kan tegen meerkosten worden aangeboden, indien dit mogelijk is gezien de locatie. Indien assistentie gewenst is, belt u een HP Service Partner om via de telefoon technische ondersteuning te ontvangen. HP vermeldt in de documentatie bij het vervangende CSR-onderdeel of het defecte onderdeel aan HP moet worden geretourneerd. Als het defecte onderdeel aan HP moet worden teruggezonden, moet u het defecte onderdeel binnen een bepaalde periode, gewoonlijk vijf (5) werkdagen, retourneren aan HP. Het defecte onderdeel moet met de bijbehorende documentatie worden geretourneerd in het meegeleverde verpakkingsmateriaal. Als u het defecte onderdeel niet terugzendt, kan HP u voor het vervangende onderdeel kosten in rekening brengen. Bij reparatie door de klant betaalt HP alle verzendkosten voor het vervangende en geretourneerde onderdeel en kiest HP zelf welke koerier/transportonderneming hiervoor wordt gebruikt.

Neem contact op met een Service Partner voor meer informatie over het Customer Self Repair programma van HP. Informatie over Service Partners vindt u op de HP website (http://www.hp.com/go/selfrepair).

Garantieservice "Parts Only"

Het is mogelijk dat de HP garantie alleen de garantieservice "Parts Only" omvat. Volgens de bepalingen van de Parts Only garantieservice zal HP kosteloos vervangende onderdelen ter beschikking stellen.

Voor de Parts Only garantieservice is vervanging door CSR-onderdelen verplicht. Als u HP verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.

Reparo feito pelo cliente

Os produtos da HP são projetados com muitas peças para reparo feito pelo cliente (CSR) de modo a minimizar o tempo de reparo e permitir maior flexibilidade na substituição de peças com defeito. Se, durante o período de diagnóstico, a HP (ou fornecedores/parceiros de serviço da HP) concluir que o reparo pode ser efetuado pelo uso de uma peça CSR, a peça de reposição será enviada diretamente ao cliente. Existem duas categorias de peças CSR:

Obrigatória – Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

Opcional – Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

OBSERVAÇÃO: Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

Conforme a disponibilidade e o local geográfico, as peças CSR serão enviadas no primeiro dia útil após o pedido. Onde as condições geográficas permitirem, a entrega no mesmo dia ou em quatro horas pode ser feita mediante uma taxa adicional. Se precisar de auxílio, entre em contato com o Centro de suporte técnico da HP para que um técnico o ajude por telefone. A HP especifica nos materiais fornecidos com a peça CSR de reposição se a peça com defeito deve ser devolvida à HP. Nos casos em que isso for necessário, é preciso enviar a peça com defeito à HP dentro do período determinado, normalmente cinco (5) dias úteis. A peça com defeito deve ser enviada com a documentação correspondente no material de transporte fornecido. Caso não o faça, a HP poderá cobrar a reposição. Para as peças de reparo feito pelo cliente, a HP paga todas as despesas de transporte e de devolução da peça e determina a transportadora/serviço postal a ser utilizado.

Para obter mais informações sobre o programa de reparo feito pelo cliente da HP, entre em contato com o fornecedor de serviços local. Para o programa norte-americano,   visite o site da HP (http://www.hp.com/go/selfrepair).

Serviço de garantia apenas para peças

A garantia limitada da HP pode incluir um serviço de garantia apenas para peças. Segundo os termos do serviço de garantia apenas para peças, a HP fornece as peças de reposição sem cobrar nenhuma taxa.

No caso desse serviço, a substituição de peças CSR é obrigatória. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

カスタマーセルフリペア

修理時間を短縮し、故障部品の交換における高い柔軟性を確保するために、HP製品には多数のCSR部品があります。診断の際に、CSR部品を使用すれば修理ができるとHP（HPまたはHP正規保守代理店）が判断した場合、HPはその部品を直接、お客様に発送し、お客様に交換していただきます。CSR部品には以下の2通りがあります。

- **必須 -** カスタマーセルフリペアが必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。
- **任意 -** カスタマーセルフリペアが任意である部品。この部品もカスタマーセルフリペア用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

注： HP製品の一部の部品は、カスタマーセルフリペア用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品がカスタマーセルフリペア除外品である旨が記載されています。

部品供給が可能な場合、地域によっては、CSR部品を翌営業日に届くように発送します。また、地域によっては、追加費用を負担いただくことにより同日または4時間以内に届くように発送することも可能な場合があります。サポートが必要なときは、HPの修理受付窓口に電話していただければ、技術者が電話でアドバイスします。交換用のCSR部品または同梱物には、故障部品をHPに返送する必要があるかどうかが表示されています。故障部品をHPに返送する必要がある場合は、指定期限内（通常は5営業日以内）に故障部品をHPに返送してください。故障部品を返送する場合は、届いた時の梱包箱に関連書類とともに入れてください。故障部品を返送しない場合、HPから部品費用が請求されます。カスタマーセルフリペアの際には、HPは送料および部品返送費を全額負担し、使用する宅配便会社や運送会社を指定します。

部品のみ保証サービス

HP保証サービスには、部品のみ保証サービスが適用される場合があります。このサービスでは、交換部品は無償で提供されます。

部品のみ保証サービスにおいては、CSR部品をお客様により交換作業していただくことが必須となります。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費はお客様の負担となります。

客户自行维修

HP 产品提供许多客户自行维修 (CSR) 部件，以尽可能缩短维修时间和在更换缺陷部件方面提供更大的灵活性。如果在诊断期间 HP（或 HP 服务提供商或服务合作伙伴）确定可以通过使用 CSR 部件完成维修，HP 将直接把该部件发送给您进行更换。有两类 CSR 部件：

- **强制性的** — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。
- **可选的** — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

注：某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为"否"。

CSR 部件将在下一个工作日发运（取决于备货情况和允许的地理范围）。在允许的地理范围内，可在当天或四小时内发运，但要收取额外费用。如果需要帮助，您可以致电 HP 技术支持中心，将会有技术人员通过电话为您提供帮助。HP 会在随更换的 CSR 部件发运的材料中指明是否必须将有缺陷的部件返还给 HP。如果要求您将有缺陷的部件返还给 HP，那么您必须在规定期限内（通常是五 (5) 个工作日）将缺陷部件发给 HP。有缺陷的部件必须随所提供的发运材料中的相关文件一起返还。如果未能送还有缺陷的部件，HP 可能会要求您支付更换费用。客户自行维修时，HP 将承担所有相关运输和部件返回费用，并指定快递商/承运商。

有关 HP 客户自行维修计划的详细信息，请与您当地的服务提供商联系。有关北美地区的计划，请访问 HP 网站 (http://www.hp.com/go/selfrepair)。

仅部件保修服务

您的 HP 有限保修服务可能涉及仅部件保修服务。根据仅部件保修服务条款的规定，HP 将免费提供更换的部件。

仅部件保修服务要求进行 CSR 部件更换。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

客戶自行維修

HP 產品設計了許多「客戶自行維修」(CSR) 的零件以減少維修時間,並且使得更換瑕疵零件時能有更大的彈性。如果在診斷期間 HP(或 HP 服務供應商或維修夥伴)辦認出此項維修工作可以藉由使用 CSR 零件來完成,則 HP 將直接寄送該零件給您作更換。CSR 零件分為兩種類別:

* **強制的** — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件,HP 將會向您收取此服務所需的外出費用與勞動成本。

* **選購的** — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過,如果您要求 HP 為您更換,則可能需要也可能不需要負擔額外的費用,端視針對此產品指定的保固服務類型而定。

備註:某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固,HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中,被標示為「否」。

基於材料取得及環境允許的情況下,CSR 零件將於下一個工作日以快遞寄送。在環境的允許下當天或四小時內送達,則可能需要額外的費用。若您需要協助,可致電「HP 技術支援中心」,會有一位技術人員透過電話來協助您。不論損壞的零件是否必須退回,HP 皆會在與 CSR 替換零件一起運送的材料中註明。若要將損壞的零件退回 HP,您必須在指定的一段時間內(通常為五 (5) 個工作天),將損壞的零件寄回 HP。損壞的零件必須與寄送資料中隨附的相關技術文件一併退還。如果無法退還損壞的零件,HP 可能要向您收取替換費用。針對客戶自行維修情形,HP 將負責所有運費及零件退還費用並指定使用何家快遞/貨運公司。

如需 HP 的「客戶自行維修」方案詳細資訊,請連絡您當地的服務供應商。至於北美方案,請參閱 HP 網站 (http://www.hp.com/go/selfrepair)。

僅限零件的保固服務

您的「HP 有限保固」可能包含僅限零件的保固服務。在僅限零件的保固服務情況下,HP 將免費提供替換零件。

針對僅限零件的保固服務,CSR 零件替換是強制性的。如果您要求 HP 更換這些零件,HP 將會向您收取此服務所需的外出費用與勞動成本。

고객 셀프 수리

HP 제품은 수리 시간을 최소화하고 결함이 있는 부품 교체 시 더욱 융통성을 발휘할 수 있도록 하기 위해 고객 셀프 수리(CSR) 부품을 다량 사용하여 설계되었습니다. 진단 기간 동안 HP(또는 HP 서비스 공급업체 또는 서비스 협력업체)에서 CSR 부품을 사용하여 수리가 가능하다고 판단되면 HP는 해당 부품을 바로 사용자에게 보내어 사용자가 교체할 수 있도록 합니다. CSR 부품에는 두 가지 종류가 있습니다.

- **고객 셀프 수리가 의무 사항인 필수 부품.** 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.
- **고객 셀프 수리가 선택 사항인 부품.** 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

참고: 일부 HP 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

CSR 부품은 재고 상태와 지리적 조건이 허용하는 경우 다음 영업일 납품이 가능하도록 배송이 이루어집니다. 지리적 조건이 허용하는 경우 추가 비용이 청구되는 조건으로 당일 또는 4시간 배송이 가능할 수도 있습니다. 도움이 필요하시면 HP 기술 지원 센터로 전화하십시오. 전문 기술자가 전화로 도움을 줄 것입니다. HP는 결함이 발생한 부품을 HP로 반환해야 하는지 여부를 CSR 교체 부품과 함께 배송된 자료에 지정합니다. 결함이 발생한 부품을 HP로 반환해야 하는 경우에는 지정된 기간 내(통상 영업일 기준 5일)에 HP로 반환해야 합니다. 이 때 결함이 발생한 부품은 제공된 포장 재료에 넣어 관련 설명서와 함께 반환해야 합니다. 결함이 발생한 부품을 반환하지 않는 경우 HP가 교체 부품에 대해 비용을 청구할 수 있습니다. 고객 셀프 수리의 경우, HP는 모든 운송 및 부품 반환 비용을 부담하며 이용할 운송업체 및 택배 서비스를 결정합니다.

HP 고객 셀프 수리 프로그램에 대한 자세한 내용은 가까운 서비스 제공업체에 문의하십시오. 북미 지역의 프로그램에 대해서는 HP 웹 사이트(http://www.hp.com/go/selfrepair)를 참조하십시오.

부품 제공 보증 서비스

HP 제한 보증에는 부품 제공 보증 서비스가 포함될 수 있습니다. 이러한 경우 HP는 부품 제공 보증 서비스의 조건에 따라 교체 부품만을 무료로 제공합니다.

부품 제공 보증 서비스 제공 시 CSR 부품 교체는 의무 사항입니다. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

Illustrated parts catalog

Mechanical components

HP continually improves and changes product parts. For complete and current supported parts information, see the HP PartSurfer website (http://partsurfer.hp.com).
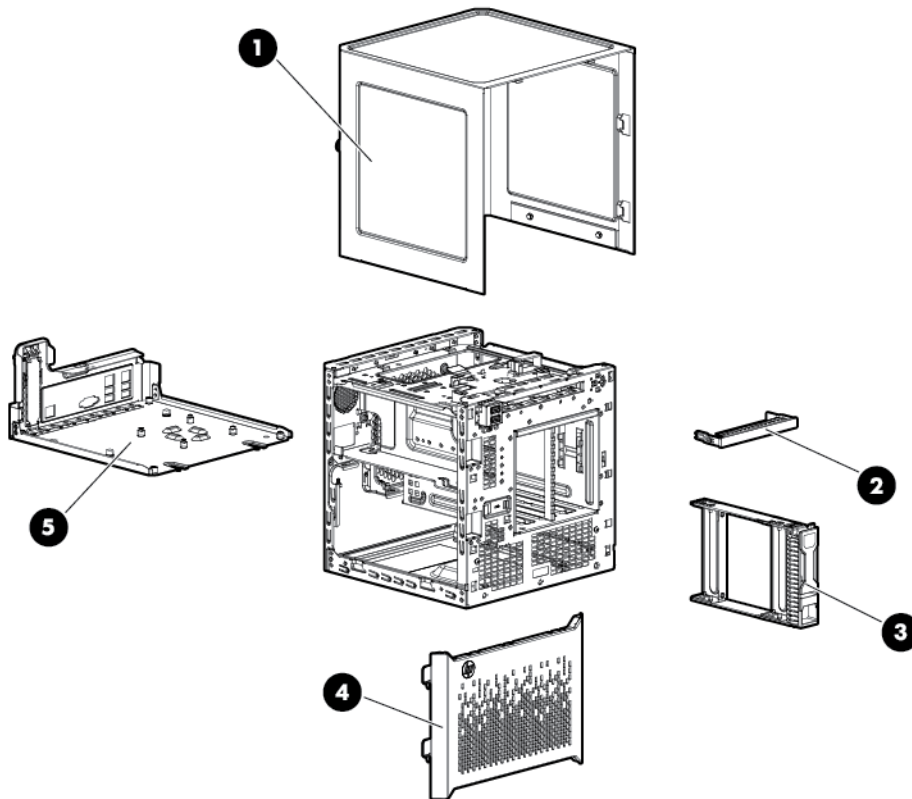
Item	Description	Spare part number	Customer self repair (on page 5)
1	Chassis cover	724494-001	Mandatory[1]
2	Optical drive blank	724499-001	Mandatory[1]
3	LFF non-hot-plug drive carrier*	691585-001	Mandatory[1]
4	Front bezel assembly	724490-001	Mandatory[1]
5	System board tray	724500-001	Mandatory[1]

* When no drive is installed in the non-hot-plug drive carrier, it serves as a blank for a non-hot-plug drive configuration.
[1]Mandatory—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.
[2]Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

[3]No—Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

[1]Mandatory: Obligatoire—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.
[2]Optional: Facultatif—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.
[3]No: Non—Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

[1]Mandatory: Obbligatorie—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.
[2]Optional: Opzionali—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.
[3]No: Non CSR—Alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

[1]Mandatory: Zwingend—Teile, die im Rahmen des Customer Self Repair Programms ersetzt werden müssen. Wenn Sie diese Teile von HP ersetzen lassen, werden Ihnen die Versand- und Arbeitskosten für diesen Service berechnet.
[2]Optional: Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.
[3]No: Kein—Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No" bzw. „Nein" gekennzeichnet.

[1]Mandatory: Obligatorio—componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.
[2]Optional: Opcional— componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.
[3]No: No—Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

[1]Mandatory: Verplicht—Onderdelen waarvoor Customer Self Repair verplicht is. Als u HP verzoekt deze onderdelen te vervangen, komen de reiskosten en het arbeidsloon voor uw rekening.
[2]Optional: Optioneel—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.
[3]No: Nee—Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

[1]Mandatory: Obrigatória—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.
[2]Optional: Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

[3]No: Nenhuma—Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

[1]Mandatory：必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。

[2]Optional：任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、費用を負担していただくことなく保証サービスを受けることができます。

[3]No：除外 - HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

[1]Mandatory: 强制性的 — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

[2]Optional: 可选的 — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

[3]No: 否 — 某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为"否"。

[1]Mandatory: 强制的 — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

[2]Optional: 選購的 — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

[3]No: 否 — 某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

[1] Mandatory: 필수 — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

[2] Optional: 옵션 — 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

[3] No: No — 고객 셀프 수리가 불가능하도록 설계된 HP 부품. 이 부품들은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 고객 보증을 만족시키기 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다.

System components

HP continually improves and changes product parts. For complete and current supported parts information, see the HP PartSurfer website (http://partsurfer.hp.com).
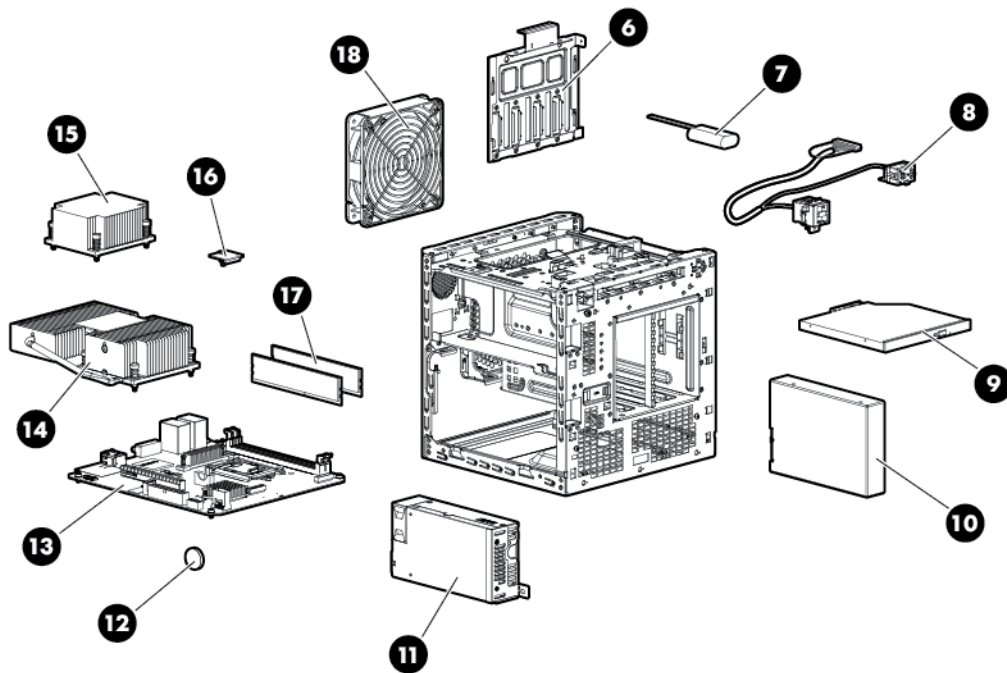
Item	Description	Spare part number	Customer self repair (on page 5)
6	LFF non-hot-plug drive cable assembly	724493-001	Mandatory[1]
7	Capacitor pack	671353-001	Mandatory[1]
8	Front I/O module assembly	724492-001	No[3]
9	SATA DVD-RW optical drive (9.5 mm, 0.37 in)	724498-001	Mandatory[1]
10	LFF non-hot-plug 6G SATA drives (8.89 cm, 3.5 in)	—	—
	a) 500 GB drive	659571-001	Mandatory[1]
	b) 1 TB drive*	659569-001	Mandatory[1]
	c) 2 TB drive*	659570-001	Mandatory[1]
	d) 3 TB drive*	628183-001	Mandatory[1]
	e) 4 TB drive*	801925-001	Mandatory[1]
11	Power supplies	—	—
	a) HP 150 W Integrated Power Supply	724496-001	Mandatory[1]
	b) HP 200 W Integrated Power Supply*	724497-001	Mandatory[1]
12	System battery, 3.3-V lithium	234556-001	Mandatory[1]
13	System board (include alcohol pad and thermal compound)	724495-001	Mandatory[1]
14	Heatsink for processors with a TDP higher than 35 W	832667-001	Optional[2]
15	Heatsink for processors with a TDP of 35 W and below	724501-001	Optional[2]
16	Processors (include alcohol pad and thermal compound)	—	—

Item	Description	Spare part number	Customer self repair (on page 5)
	a) 2.30-GHz Intel Celeron G1610T processor, 2C, 2 MB, 35 W	730232-001	Optional[2]
	b) 2.30-GHz Intel Xeon E3-1220L v2 processor, 2C, 3 MB, 17 W*	686687-001	Optional[2]
	c) 2.50-GHz Intel Pentium G2020T processor, 2C, 3 MB, 35 W*	731127-001	Optional[2]
	d) 3.40-GHz Intel Core i3-3240 processor, 2C, 3 MB, 55 W*	688951-001	Optional[2]
17	DIMMs	—	—
	a) 2 GB, single-rank x8 PC3-12800E-11	684033-001	Mandatory[1]
	b) 2 GB, single-rank x8 PC3L-10600E-9*	664694-001	Mandatory[1]
	c) 4 GB, single-rank x8 PC3-12800E*	823810-001	Mandatory[1]
	d) 4 GB, dual-rank x8 PC3-12800E-11*	684034-001	Mandatory[1]
	e) 4 GB, dual-rank x8 PC3L-10600E-9*	664695-001	Mandatory[1]
	f) 8 GB, dual-rank x8 PC3-12800E-11*	684035-001	Mandatory[1]
	g) 8 GB, dual-rank x8 PC3L-10600E-9*	664696-001	Mandatory[1]
18	System fan	724491-001	Mandatory[1]
19	Optical drive SATA-Y cable*	689392-001	Mandatory[1]
20	Ambient temperature sensor cable*	725205-001	No[3]

* Not shown

[1]Mandatory—Parts for which customer self repair is mandatory. If you request HP to replace these parts, you will be charged for the travel and labor costs of this service.

[2]Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that HP replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

[3]No—Some HP parts are not designed for customer self repair. In order to satisfy the customer warranty, HP requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

[1]Mandatory: Obligatoire—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à HP de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

[2]Optional: Facultatif—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à HP de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

[3]No: Non—Certaines pièces HP ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, HP exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

[1]Mandatory: Obbligatorie—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad HP, deve sostenere le spese di spedizione e di manodopera per il servizio.

[2]Optional: Opzionali—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad HP, potrebbe dover sostenere spese addizionali a seconda del tipo di garanzia previsto per il prodotto.

[3]No: Non CSR—Alcuni componenti HP non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, HP richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

[1]Mandatory: Zwingend—Teile, die im Rahmen des Customer Self Repair Programms ersetzt werden müssen. Wenn Sie diese Teile von HP ersetzen lassen, werden Ihnen die Versand- und Arbeitskosten für diesen Service berechnet.

[2]Optional: Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von HP vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

[3]No: Kein—Einige Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem HP Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No" bzw. „Nein" gekennzeichnet.

[1]Mandatory: Obligatorio—componentes para los que la reparación por parte del usuario es obligatoria. Si solicita a HP que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

[2]Optional: Opcional— componentes para los que la reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que HP realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

[3]No: No—Algunos componentes no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, HP pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

[1]Mandatory: Verplicht—Onderdelen waarvoor Customer Self Repair verplicht is. Als u HP verzoekt deze onderdelen te vervangen, komen de reiskosten en het arbeidsloon voor uw rekening.

[2]Optional: Optioneel—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter HP verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

[3]No: Nee—Sommige HP onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

[1]Mandatory: Obrigatória—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a HP substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

[2]Optional: Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a HP as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

[3]No: Nenhuma—Algumas peças da HP não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a HP exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

[1]Mandatory：必須 - 顧客自己修理が必須の部品。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。

[2]Optional：任意 - 顧客自己修理が任意である部品。この部品も顧客自己修理用です。当該部品について、もしもお客様がHPに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、費用を負担していただくことなく保証サービスを受けることができます。

[3]No：除外 - HP製品の一部の部品は、顧客自己修理用ではありません。製品の保証を継続するためには、HPまたはHP正規保守代理店による交換作業が必須となります。部品カタログには、当該部品が顧客自己修理除外品である旨が記載されています。

[1]Mandatory: 强制性的 — 要求客户必须自行维修的部件。如果您请求 HP 更换这些部件，则必须为该服务支付差旅费和人工费用。

[2]Optional: 可选的 — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 HP 为您更换这些部件，则根据为您的产品指定的保修服务类型，HP 可能收取或不再收取任何附加费用。

[3]No: 否 — 某些 HP 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，HP 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为"否"。

[1]Mandatory: 强制的 — 客戶自行維修所使用的零件是強制性的。如果您要求 HP 更換這些零件，HP 將會向您收取此服務所需的外出費用與勞動成本。

[2]Optional: 選購的 — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 HP 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

[3]No: 否 — 某些 HP 零件沒有消費者可自行維修的設計。為符合客戶保固，HP 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

[1] Mandatory: 필수 — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 HP에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

[2] Optional: 옵션 — 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 HP에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

[3] No: No — 고객 셀프 수리가 불가능하도록 설계된 HP 부품. 이 부품들은 고객 셀프 수리가 불가능하도록 설계되었습니다. HP는 고객 보증을 만족시키기 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다.

Removal and replacement procedures

Required tools

You need the following items for some procedures:

- L-wrench (on page 78)
- HP Insight Diagnostics (on page 67)

Safety considerations

Before performing service procedures, review all the safety information.

Preventing electrostatic discharge

To prevent damaging the system, be aware of the precautions you need to follow when setting up the system or handling parts. A discharge of static electricity from a finger or other conductor may damage system boards or other static-sensitive devices. This type of damage may reduce the life expectancy of the device.

To prevent electrostatic damage:

- Avoid hand contact by transporting and storing products in static-safe containers.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free workstations.
- Place parts on a grounded surface before removing them from their containers.
- Avoid touching pins, leads, or circuitry.
- Always be properly grounded when touching a static-sensitive component or assembly.

Symbols on equipment

The following symbols may be placed on equipment to indicate the presence of potentially hazardous conditions.

	This symbol indicates the presence of hazardous energy circuits or electric shock hazards. Refer all servicing to qualified personnel. **WARNING:** To reduce the risk of injury from electric shock hazards, do not open this enclosure. Refer all maintenance, upgrades, and servicing to qualified personnel.
	This symbol indicates the presence of electric shock hazards. The area contains no user or field serviceable parts. Do not open for any reason. **WARNING:** To reduce the risk of injury from electric shock hazards, do not open this enclosure.

This symbol on an RJ-45 receptacle indicates a network interface connection.

WARNING: To reduce the risk of electric shock, fire, or damage to the equipment, do not plug telephone or telecommunications connectors into this receptacle.
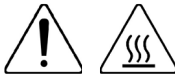
This symbol indicates the presence of a hot surface or hot component. If this surface is contacted, the potential for injury exists.

WARNING: To reduce the risk of injury from a hot component, allow the surface to cool before touching.
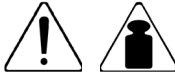
This symbol indicates that the component exceeds the recommended weight for one individual to handle safely.

WARNING: To reduce the risk of personal injury or damage to the equipment, observe local occupational health and safety requirements and guidelines for manual material handling.
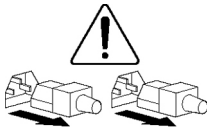
These symbols, on power supplies or systems, indicate that the equipment is supplied by multiple sources of power.

WARNING: To reduce the risk of injury from electric shock, remove all power cords to completely disconnect power from the system.

Server warnings and cautions

WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

CAUTION: Protect the server from power fluctuations and temporary interruptions with a regulating uninterruptible power supply. This device protects the hardware from damage caused by power surges and voltage spikes and keeps the system in operation during a power failure.

CAUTION: Do not operate the server for long periods with the chassis cover open or removed. Operating the server in this manner results in improper airflow and improper cooling that might lead to thermal damage.

CAUTION: When installing hardware or performing maintenance procedures requiring access to internal components, HP recommends that you first back up all server data to avoid loss.

Preparation procedures

To access some components and perform certain service procedures, perform one or more of the following procedures:

- Power down the server (on page 24).

    Before removing a non-hot-plug component from the server, you must power down the server.

- Open the front bezel (on page 25).

- Remove the front bezel (on page 26).
- Remove the chassis cover (on page 27).
- Remove the system board assembly (on page 29).

Power down the server

Before powering down the server for any upgrade or maintenance procedures, perform a backup of critical server data and programs.

⚠ **WARNING:** To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

📝 **IMPORTANT:** When the server is in standby mode, auxiliary power is still being provided to the system.

To power down the server, use one of the following methods:

- Press and release the Power On/Standby button.

  This method initiates a controlled shutdown of applications and the OS before the server enters standby mode.

- Press and hold the Power On/Standby button for more than 4 seconds to force the server to enter standby mode.

  This method forces the server to enter standby mode without properly exiting applications and the OS. If an application stops responding, you can use this method to force a shutdown.

- Use a virtual power button selection through iLO 4.

  This method initiates a controlled remote shutdown of applications and the OS before the server enters standby mode.

Before proceeding, verify the server is in standby mode by observing that the system power LED is amber.

Open the front bezel

If the front bezel is not secured from inside the chassis, open the bezel.
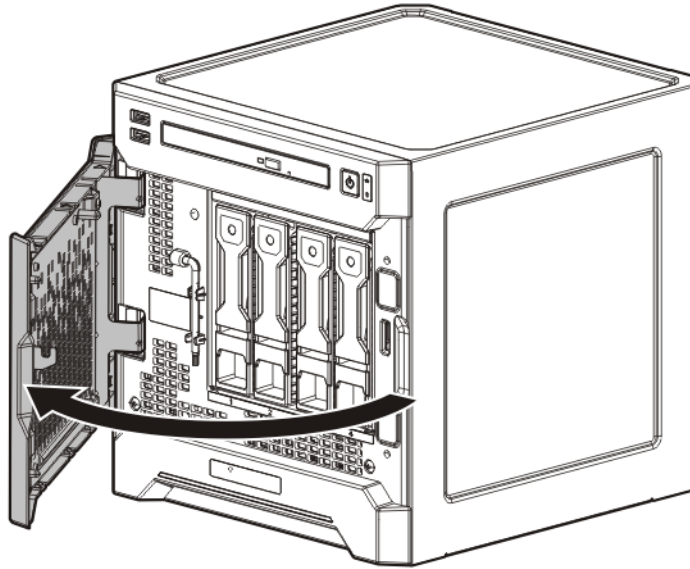
If the front bezel is secured from inside the chassis, do the following (Perform steps 1 to 3 only if the server is turned on.):

1. Power down the server (on page).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page).
5. Slide the release tab upward to unlock the front bezel from the chassis.

6. Open the front bezel.

Remove the front bezel

If the front bezel is not secured from inside the chassis, open the front bezel, and then release the hinges from the front panel.
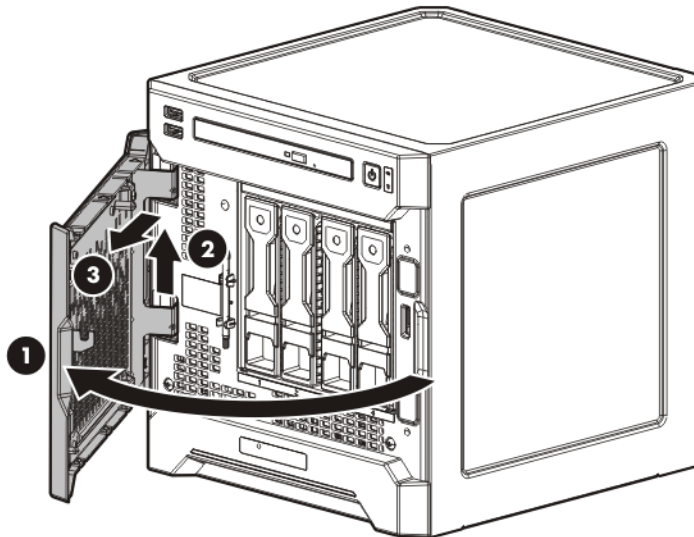
If the front bezel is secured from inside the chassis, do the following (Perform steps 1 to 3 only if the server is turned on.):

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).

5. Slide the release tab upward to unlock the front bezel from the chassis.
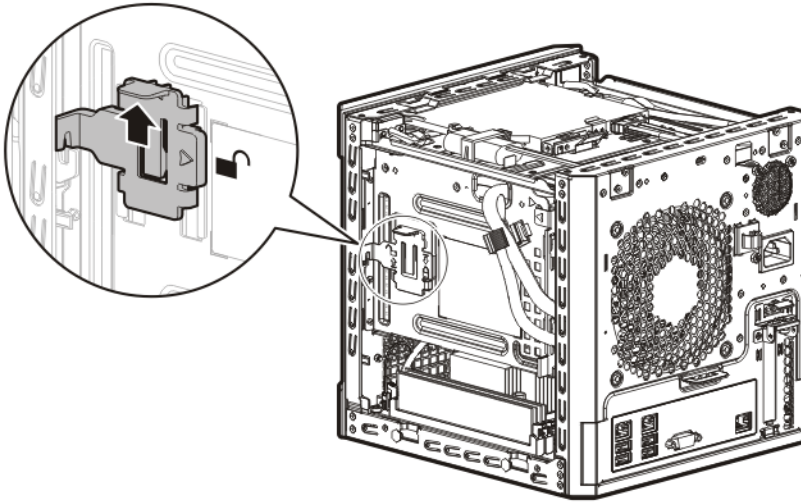
6. Open the front bezel.

7. Release the bezel hinges from the front panel.
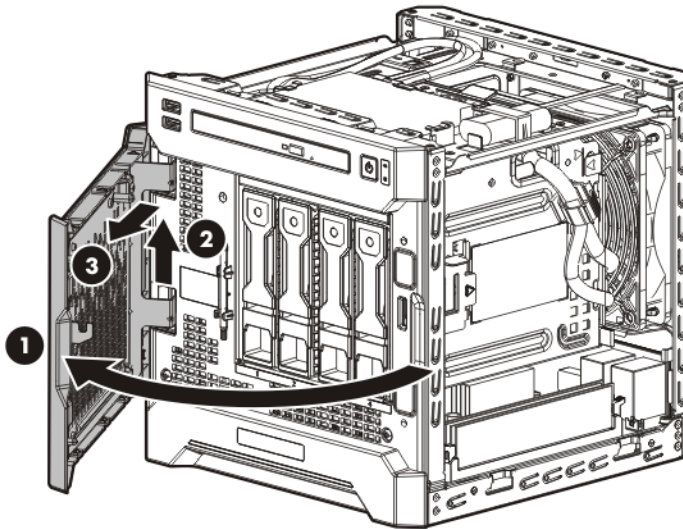
Remove the chassis cover

1. Power down the server (on page 24).

2. Disconnect the power cord from the AC source.

3. Disconnect the power cord from the server.

4. Disconnect all peripheral cables from the server.

5. If a Kensington security cable is installed, disconnect it from the rear panel. See the security cable documentation for instructions.

6. Loosen the rear thumbscrews that secure the chassis cover.

7. Slide the chassis cover toward the rear panel, and then lift it to remove it from the chassis.
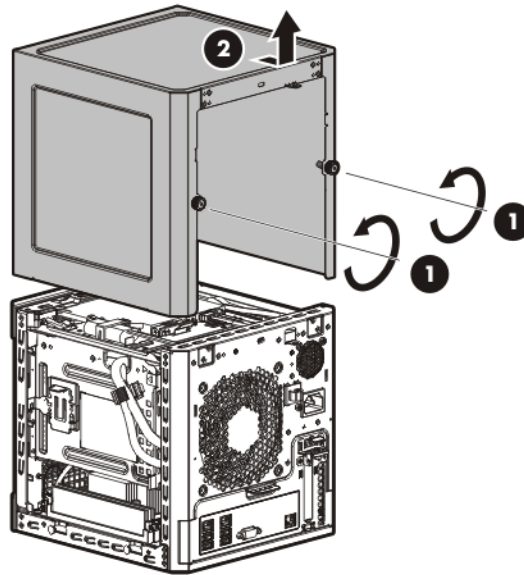
Install the chassis cover

1. Align the installation markers on the chassis cover with those located on the front edge of the chassis, and then slide the chassis cover back onto the server.

2. Tighten the rear thumbscrews to secure the chassis cover in place.
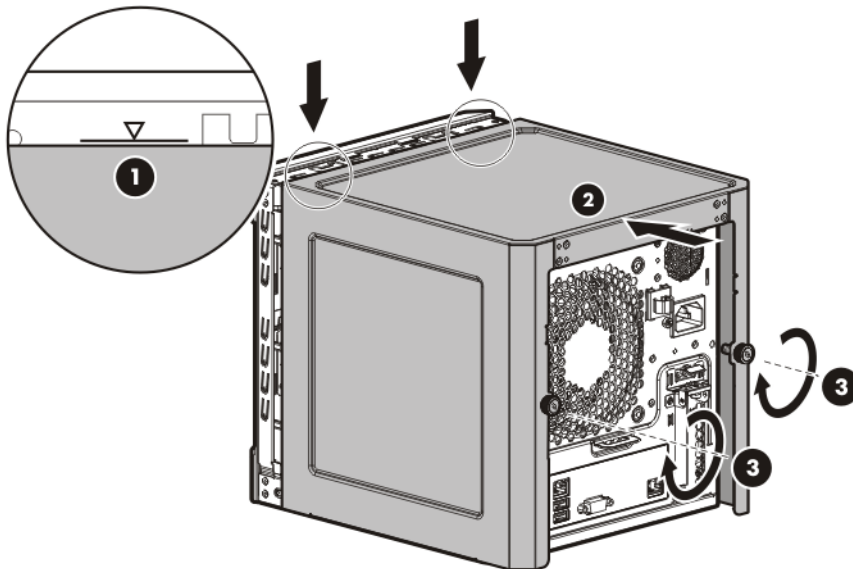
3. Connect the peripheral devices to the server.

4. If a Kensington security cable was removed, connect it to the rear panel. See the security cable documentation for instructions.

5. Connect the server to the network. Do one of the following:

    o   Connect the Ethernet cable.

    o   Connect the server to the switch.

6. Connect the power cord to the server.

7. Power up the server.

Remove the system board assembly

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. It is recommended that you take a picture of the current system board cable connections for reference during server reassembly.
6. If the drive cage is connected to a storage controller board, disconnect the Mini-SAS cable from the board.
7. Disconnect all cables connected to the system board:

   o 24-pin system board power supply cable

   o SATA cable (only if an optical drive is installed)

   o Mini-SAS cable (only if the drive cage is connected to the system board)

   o Front I/O cable (pulling up the blue loop to disconnect the cable)

   o Fan cable

   o Ambient temperature sensor cable (pulling up the brown loop to disconnect the cable)

   In the following system board illustration, the gray connectors correspond to the system board cables that you must disconnect.
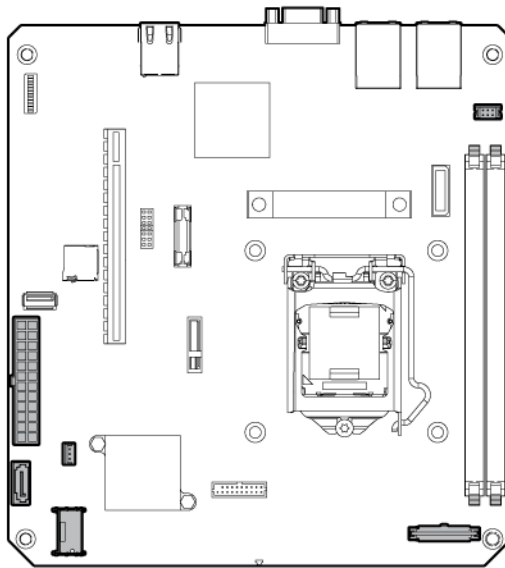
8. Press the system board tray latch.
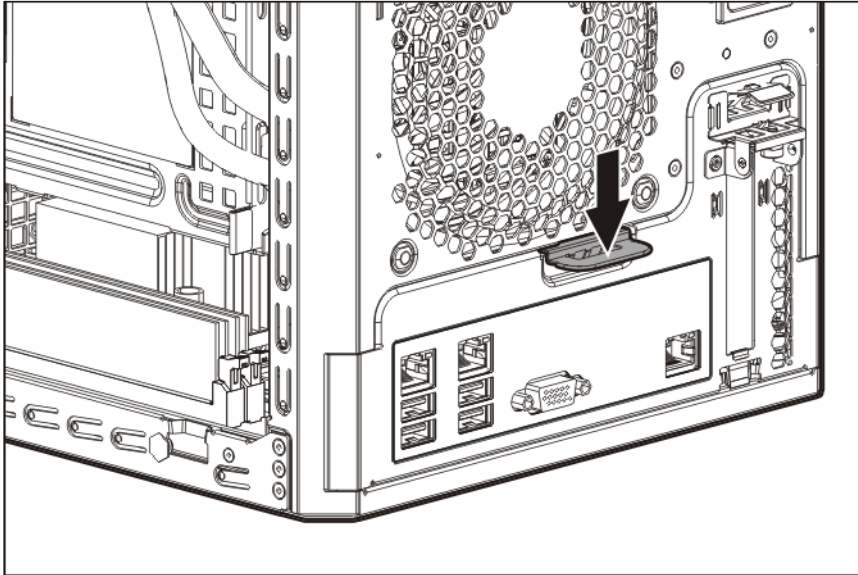
9. Slide the system board assembly completely out of the chassis.
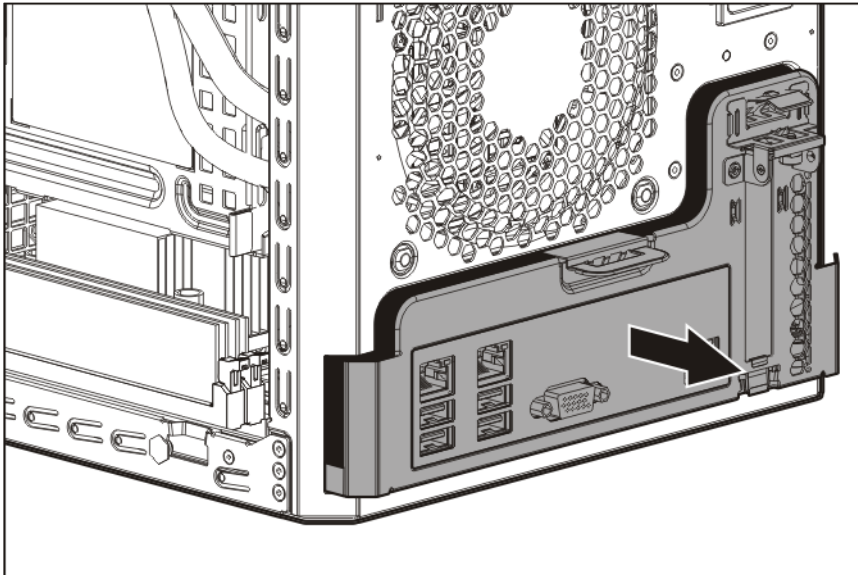
Install the system board assembly

1. Slide the system board assembly into the chassis.
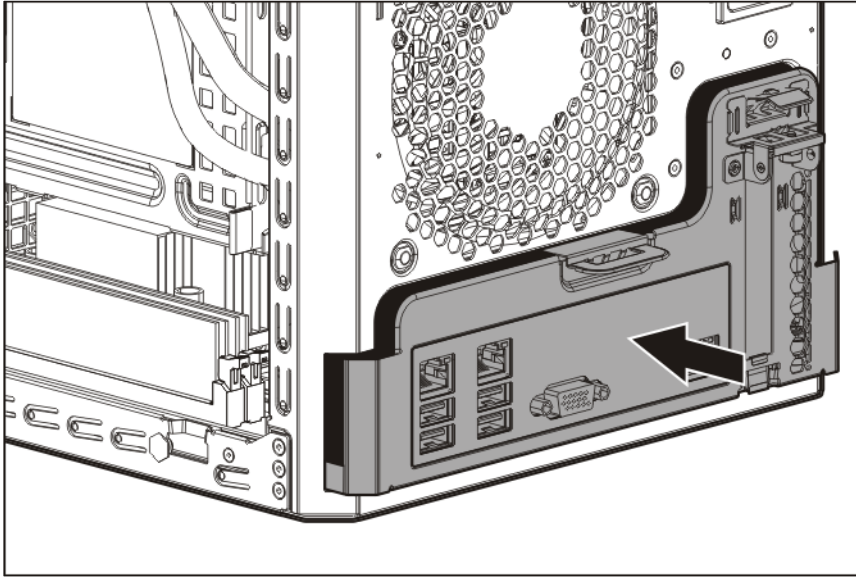
2. Connect all cables disconnected from the system board and/or expansion board.

Drive carrier

> ⚠ **CAUTION:**   To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Open the front bezel (on page).
2. Remove the drive carrier.
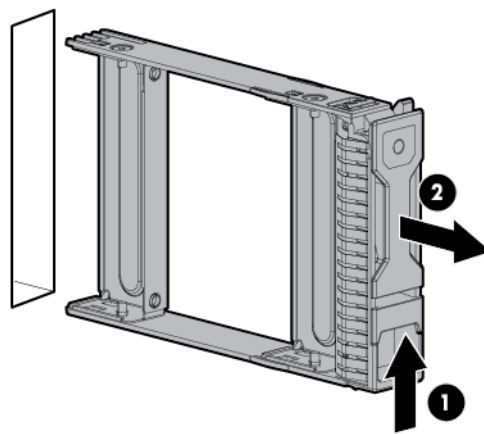
To replace the component, slide the component into the bay until it clicks.

LFF non-hot-plug drive

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Back up all server data on the drive.
2. Power down the server (on page 24).
3. If the front bezel is not secured from inside the chassis, open the bezel.
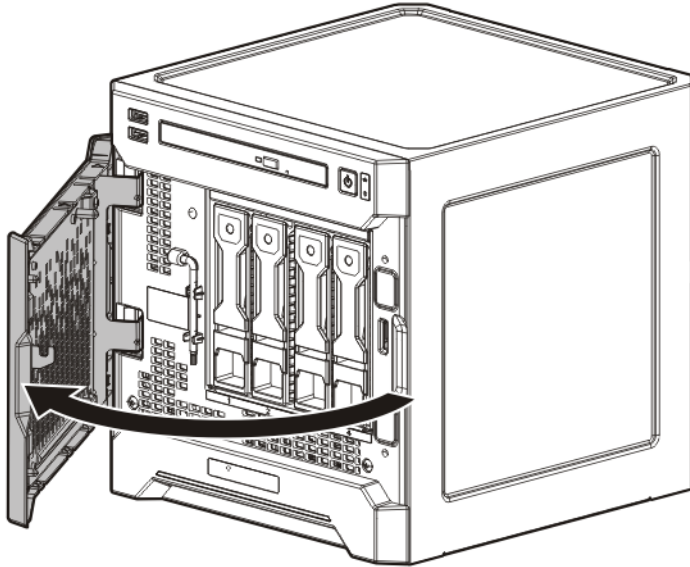
4. If the front bezel is secured from inside the chassis, do the following:
   a. Disconnect the power cord from the AC source.
   b. Disconnect the power cord from the server.
   c. Remove the chassis cover (on page 27).
   d. Open the front bezel.
   e. Release the bezel hinges from the front panel.
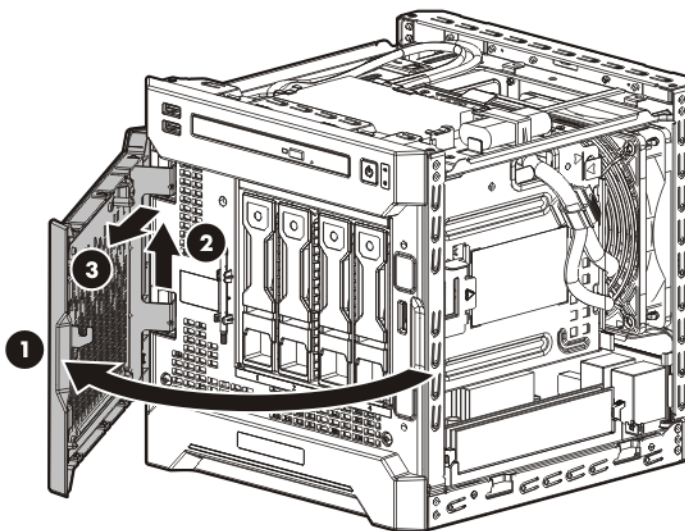
5. Remove the drive.
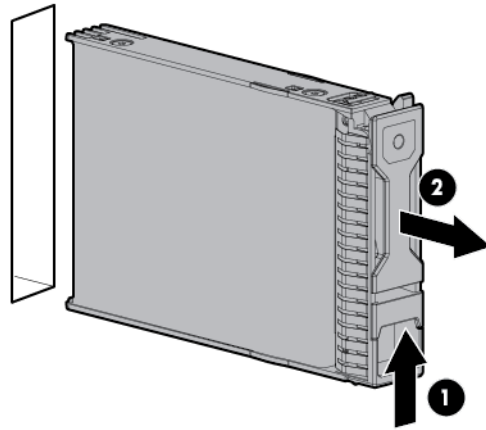
6. Remove the drive from the carrier.
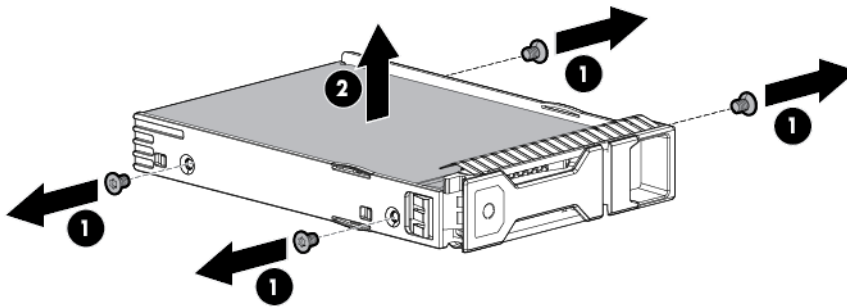
To replace the component, reverse the removal procedure.

Optical drive blank

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).

5. Press the optical drive blank release latches, and then pull the blank out of the drive bay.
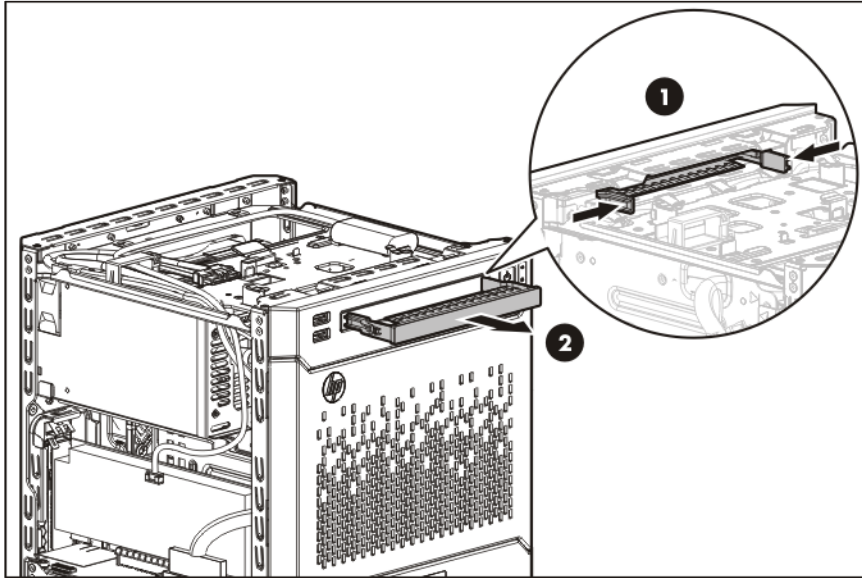
To replace the component, reverse the removal procedure.

Optical drive

⚠ **CAUTION:** To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:
1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Disconnect the optical drive cable from the drive.

6. Press the optical drive release lever, and then push the drive out of the bay.
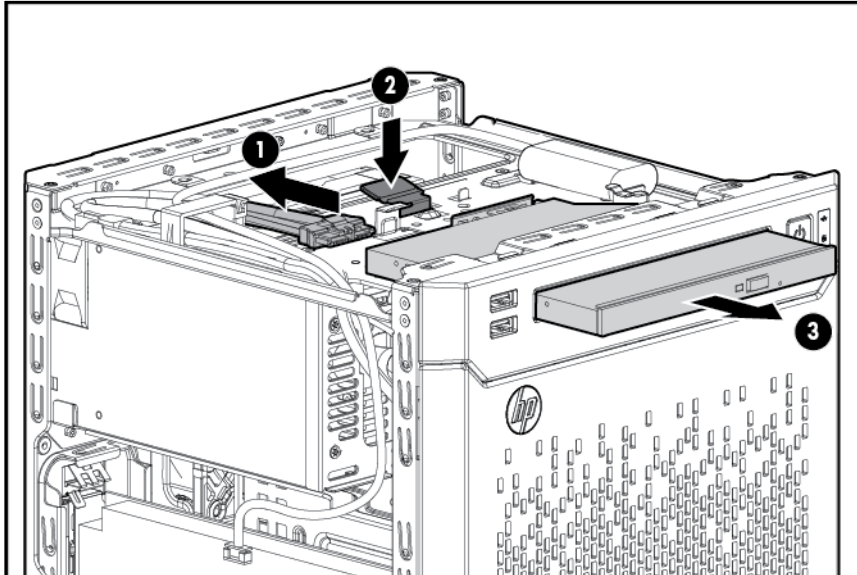
To replace the component, reverse the removal procedure.

Flash-backed write cache procedures

The following types of procedures are provided for the FBWC option:

- Removal and replacement of failed components:
  - o Removing the cache module ("FBWC module" on page 35)
  - o Removing the capacitor pack ("Capacitor pack" on page 36)
- Recovery of cached data from a failed server ("Recovering data from the flash-backed write cache" on page 38)

⚠ **CAUTION:**   Do not detach the cable that connects the battery pack or capacitor pack to the cache module. Detaching the cable causes all data in the cache module to be lost.

FBWC module

⚠ **CAUTION:**   The cache module connector does not use the industry-standard DDR3 mini-DIMMs. Do not use the controller with cache modules designed for other controller models, because the controller can malfunction and you can lose data. Also, do not transfer this cache module to an unsupported controller model, because you can lose data.

⚠ **CAUTION:**   In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

To remove the component:
1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.

4. Remove the chassis cover (on page 27).

⚠ **CAUTION:** When connecting or disconnecting the capacitor pack cable, the connectors on the cache module and cable are susceptible to damage. Avoid excessive force and use caution to avoid damage to these connectors.

5. Disconnect the capacitor pack cable from the cache module.
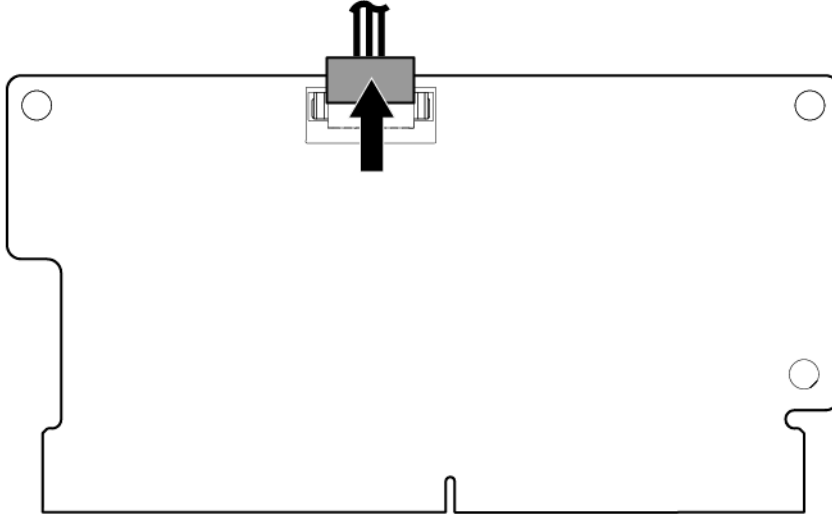
6. Remove the cache module.
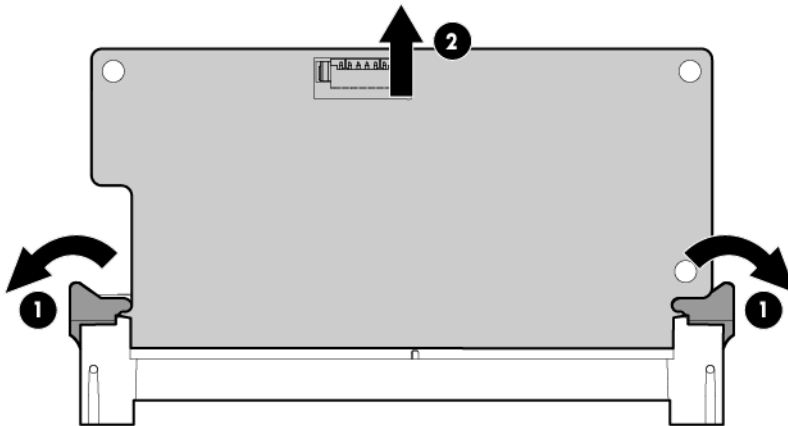
To replace the component, reverse the removal procedure.

Capacitor pack

⚠ **CAUTION:** In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

To remove the component:

1. Power down the server (on page 24).

2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. If the existing cache module is connected to a capacitor pack, observe the FBWC module LEDs:
   o If a backup is in progress, wait for the backup to complete.
   o If the backup is complete, or if the cache has failed, remove the controller from the server, and then continue with the next step.
6. Disconnect the capacitor pack cable from the cache module.
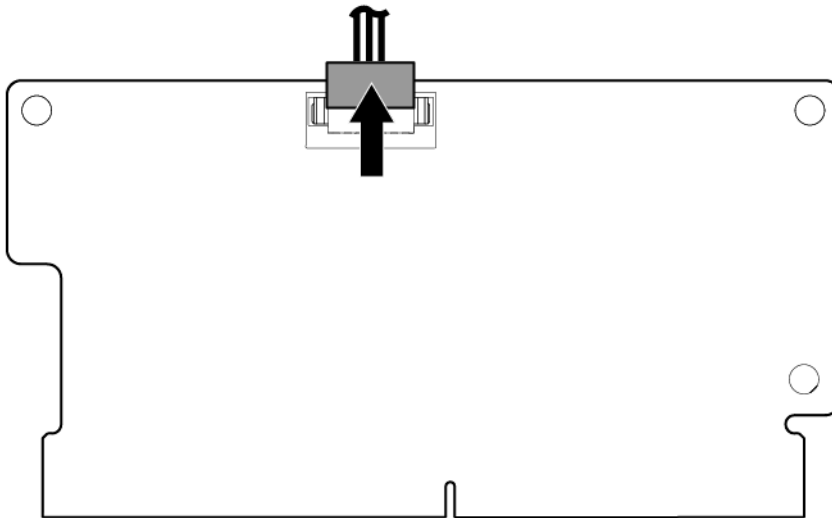
7. Open the capacitor pack holder.
8. Remove the capacitor pack.
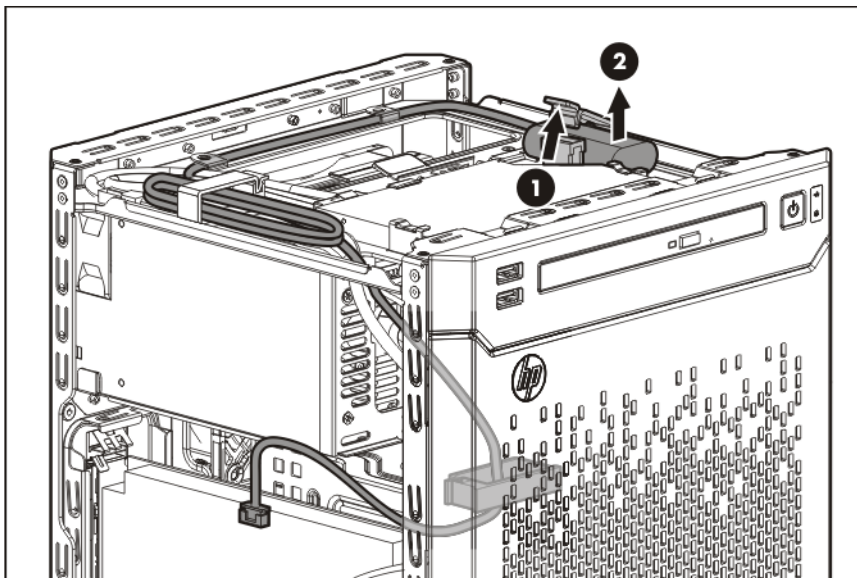
To replace the component, reverse the removal procedure.

Recovering data from the flash-backed write cache

If the server fails, use the following procedure to recover data temporarily stored in the FBWC.

⚠ **CAUTION:** Before starting this procedure, read the information about protecting against electrostatic discharge ("Preventing electrostatic discharge" on page 22).

1. Perform one of the following:

   o Set up a recovery server using an identical server model. Do not install any internal drives or FBWC in this server. (HP recommends this option.)

   o Find a server that has enough empty drive bays to accommodate all the drives from the failed server and that meets all the other requirements for drive and array migration.

2. Power down the failed server ("Power down the server" on page 24).

3. Transfer the drives from the failed server to the recovery server.

4. Perform one of the following:

   o If the array controller has failed, remove the cache module and capacitor pack from the failed array controller, and install the cache module and capacitor pack on an identical array controller model in the recovery server.

   o If the server has failed, remove the controller, cache module, and capacitor pack from the failed server, and install the controller, cache module, and capacitor pack in the recovery server.

5. Power up the recovery server. If there was data in the cache at the time of the controller or server failure, a 1792 POST message appears, stating that valid data was flushed from the cache. This data is now stored on the drives in the recovery server. You can now transfer the drives (and controller, if one is used) to another server.

   If the drives are migrated to different drive positions or there are volumes present in the recovery server, a 1724 POST message appears, stating that logical drive configuration has been updated automatically.

Front I/O module assembly

To remove the component:

1. Power down the server (on page 24).

2. Disconnect the power cord from the AC source.

3. Disconnect the power cord from the server.

4. Remove the front bezel (on page 26).

5. Remove the chassis cover (on page 27).

6. If installed, remove the optical drive ("Optical drive" on page 34).

7. If installed, remove the expansion board ("Expansion board" on page 48).

8. Remove the front panel cover:

   a. Remove the front panel cover screws.

   b. Starting from the bottom side and moving upward, release the rear side latches from their metal tabs.

c. To detach the cover from the chassis, push the latches toward the front.
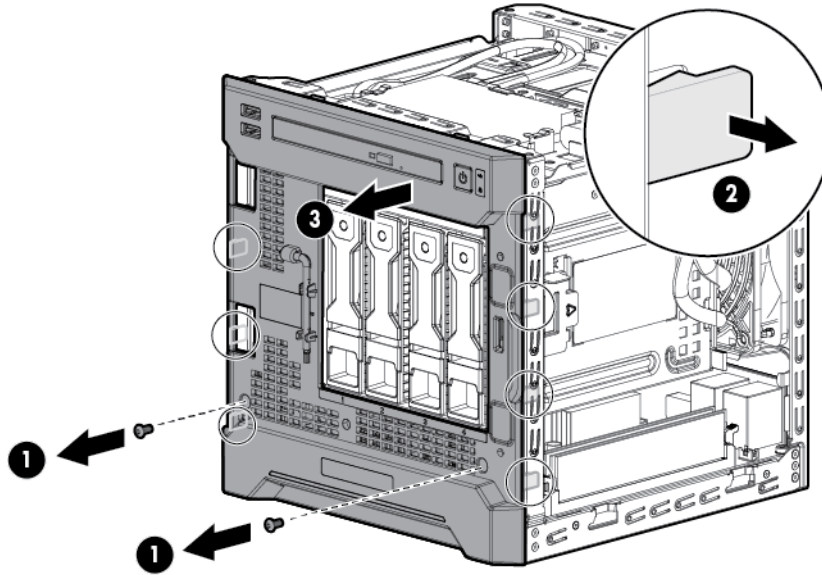
9. Remove the power button/LED module:

   a. Release the module cable from the top chassis clips.

   b. Remove the module bracket screw.

   c. Remove the module bracket.
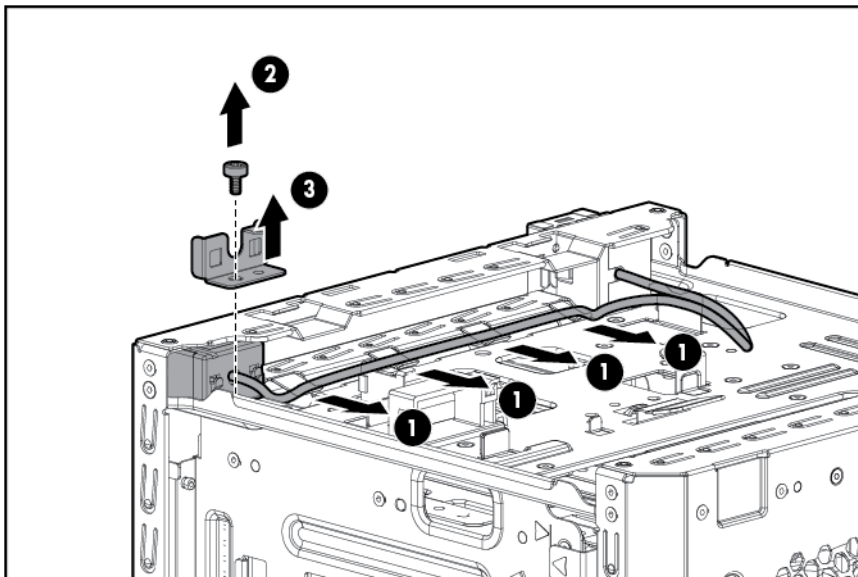
d. Press the two module latches together, and then pull the module from the chassis.
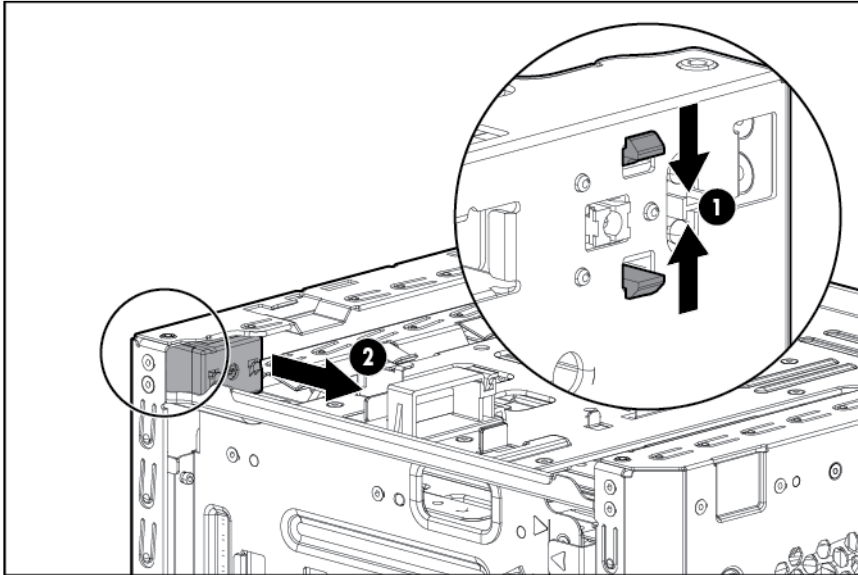
10. Remove the front USB module:
   **a.** Remove the USB module screw.
    b. Pull the USB module out of the chassis.
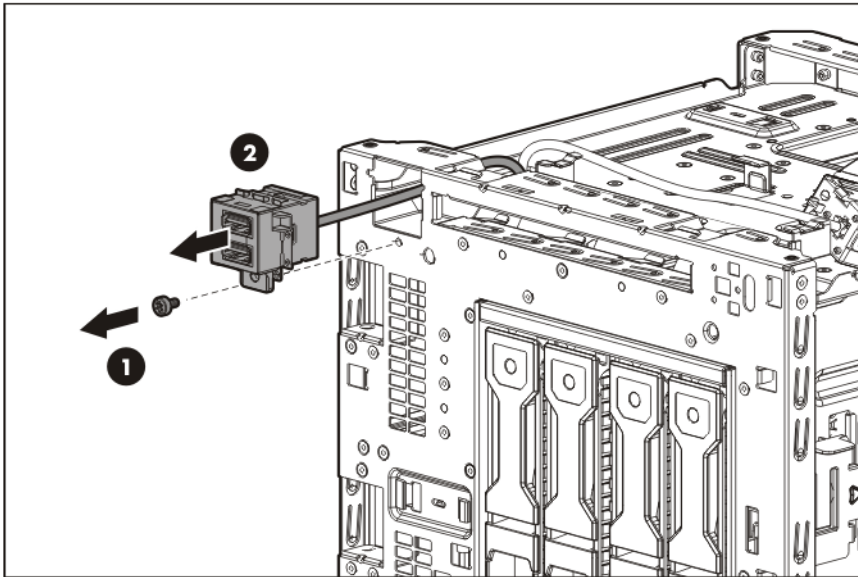
11. Remove the front I/O module assembly:
    a. Pull the blue loop to disconnect the front I/O module cable from the system board.
    b. Release the cable from the two chassis cable clips located on the underside of the drive cage.

c. Release the cable from the left-side cable clip.
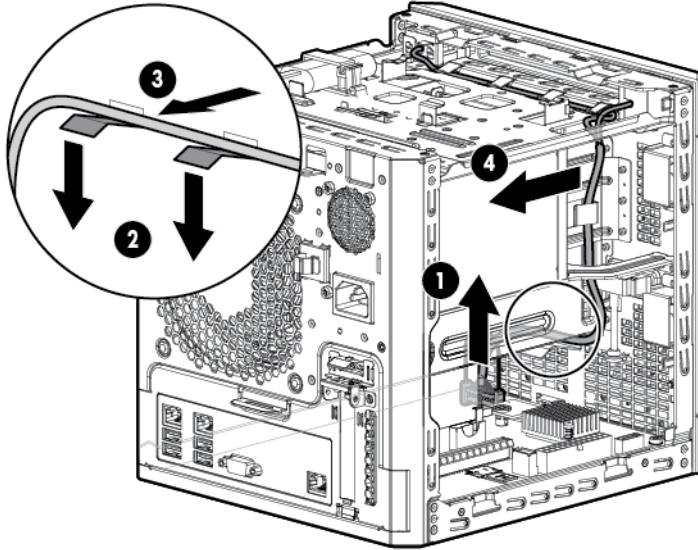
d. Pull the module cable out through the top chassis opening.

e. Pull the entire assembly out of the front USB module chassis opening.
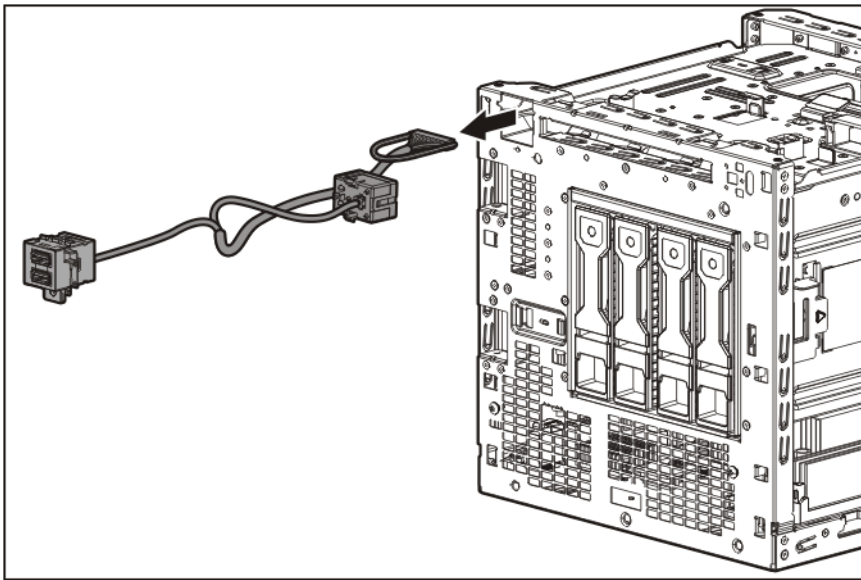
To replace the component, reverse the removal procedure.

Ambient temperature sensor cable

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the front bezel (on page 26).
5. Remove the chassis cover (on page 27).

6. Remove the ambient temperature sensor cable:

   a. Open the left-side chassis cable clip.

   b. If more working room is required, disconnect the following cables from the system board:

   — System board power cable

   — Optical drive SATA cable

   — Mini-SAS cable

   c. Pull the brown loop to disconnect the sensor cable from the system board.

   d. Detach the cable end with the rubber stopper from the chassis.
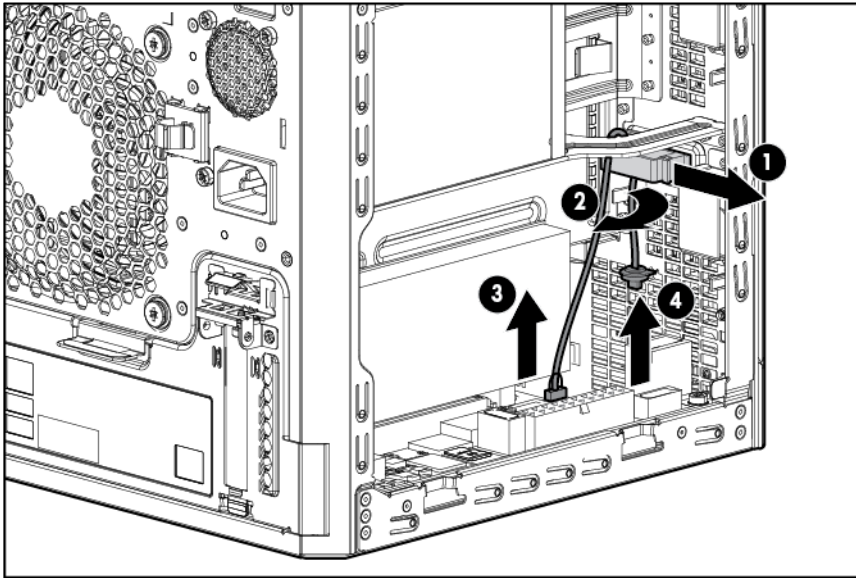
   e. Remove the rubber stopper from the sensor cable.
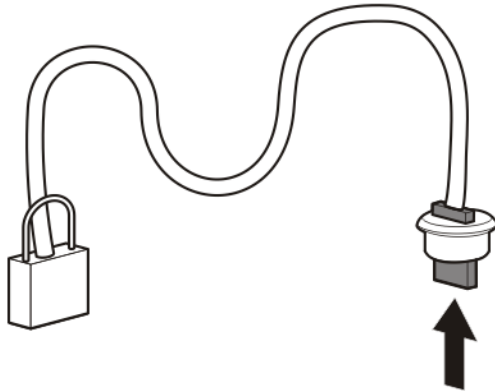
To replace the component, reverse the removal procedure.

LFF non-hot-plug drive cable assembly

The four-bay LFF non-hot-plug drive cable assembly consists of the drive power and Mini-SAS cables attached to a bracket. If either the drive power or Mini-SAS cable becomes defective, the entire cable assembly will need to be replaced (spare PN: 724493-001).
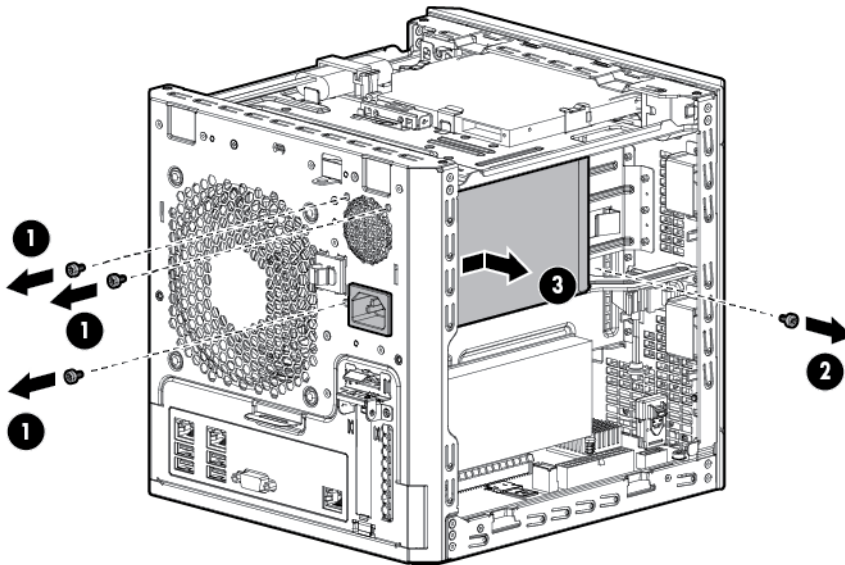
To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Open the front bezel (on page 25).
5. Remove all drives ("LFF non-hot-plug drive" on page 31) and drive carriers ("Drive carrier" on page 31).
6. If the chassis cover was not removed in step 4, remove it ("Remove the chassis cover" on page 27).
7. Open the left and right side chassis cable clips to allow the drive cable removal.
   - o Right side cable clip
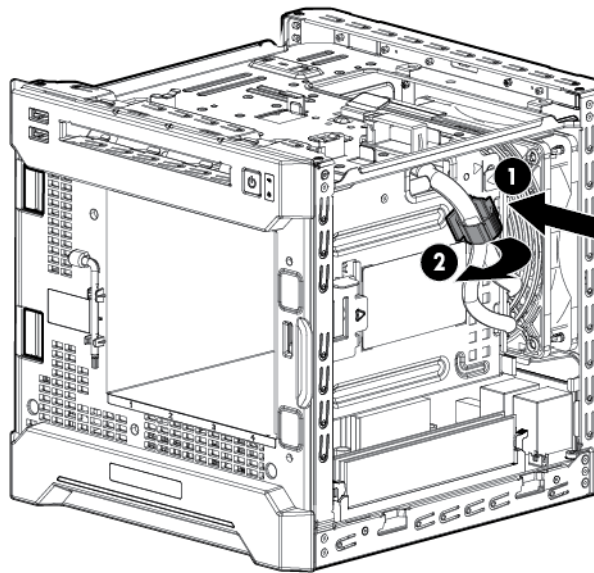
   - o Left side cable clip
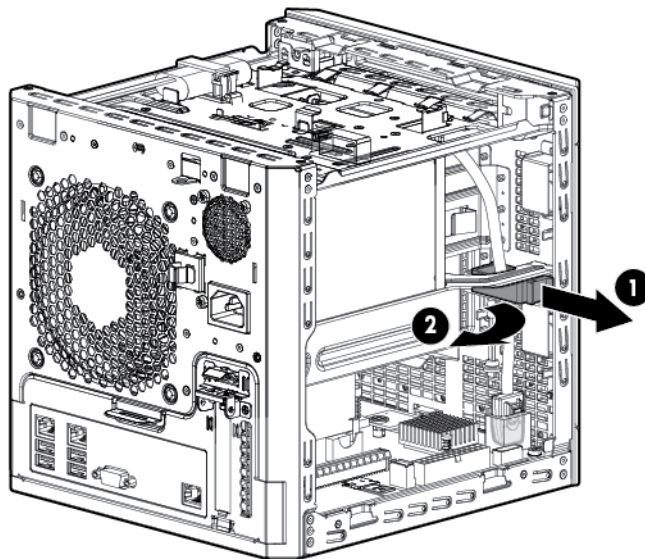
8. Disconnect the drive power cable:
   a. If installed, remove the optical drive ("Optical drive" on page 34).

b. Pull the drive power cable out from the top chassis opening.

c. Disconnect the drive power cable from the PSU 4-pin drive power connector.
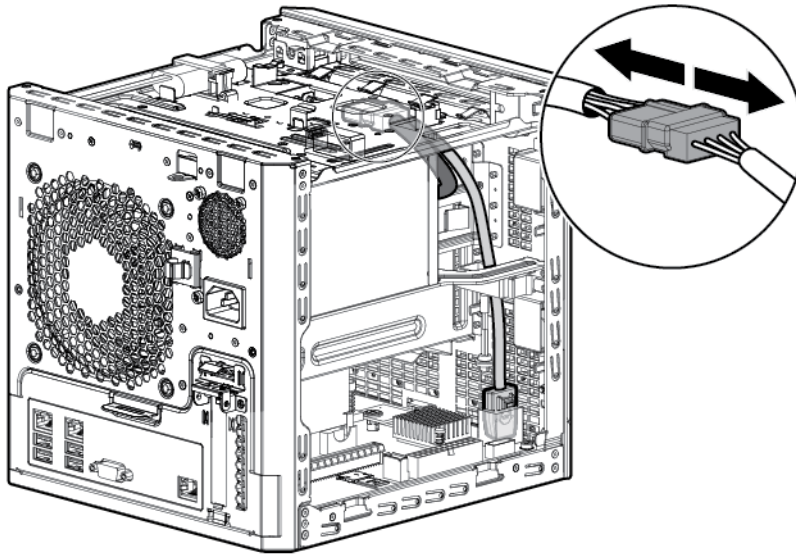
d. Pull the drive power cable out from the right side chassis opening.
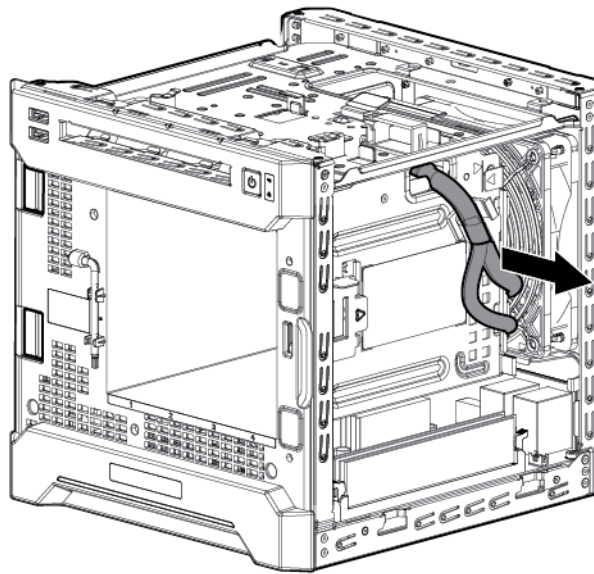
9. Release the Mini-SAS cable from the chassis:

a. Disconnect the Mini-SAS cable from the system board or from a storage controller.
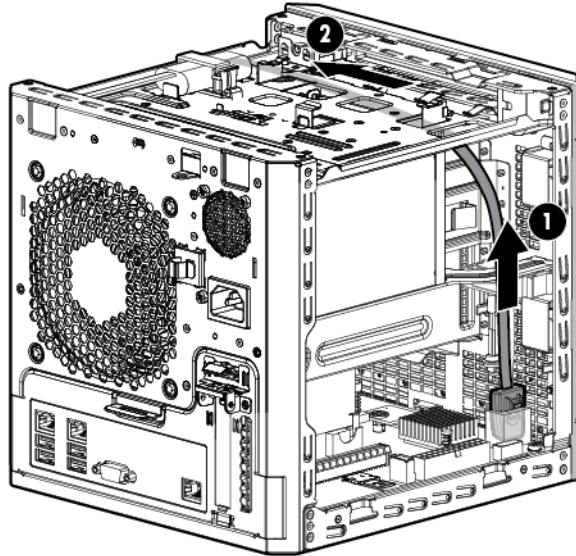
b. Pull the Mini-SAS cable out from the left side chassis opening toward the right side one until the cable is released from the chassis.
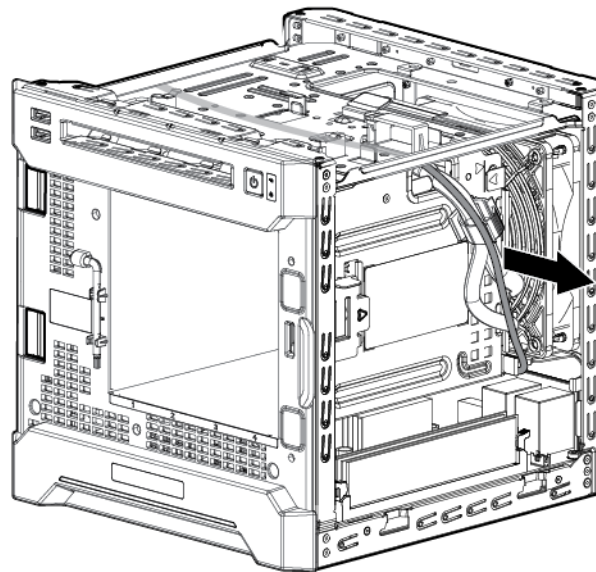
10. Remove the non-hot-plug drive cable assembly:

   a. Remove the bracket screws.

   b. To release the bracket from the chassis tabs, pull it up and move it backward.
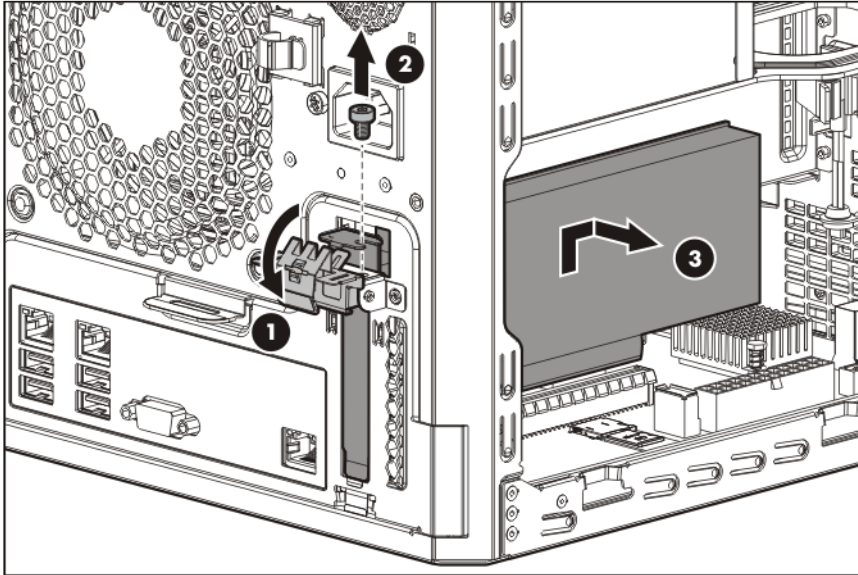
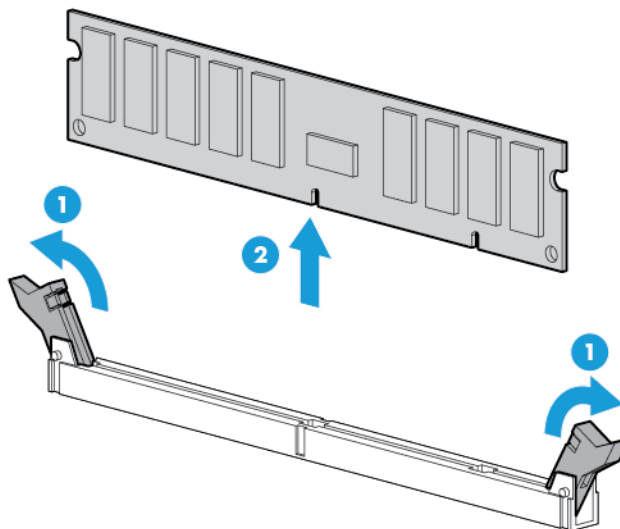**c.** Pull the cable assembly out of the chassis.
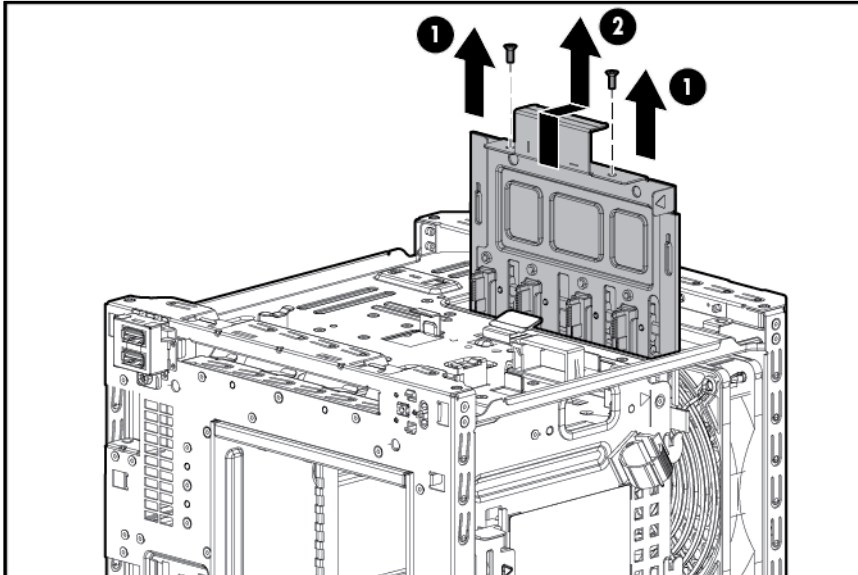
To replace the component, reverse the removal procedure.

System fan

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Disconnect the fan cable.
6. Remove the screws securing the system fan, and then remove the fan.
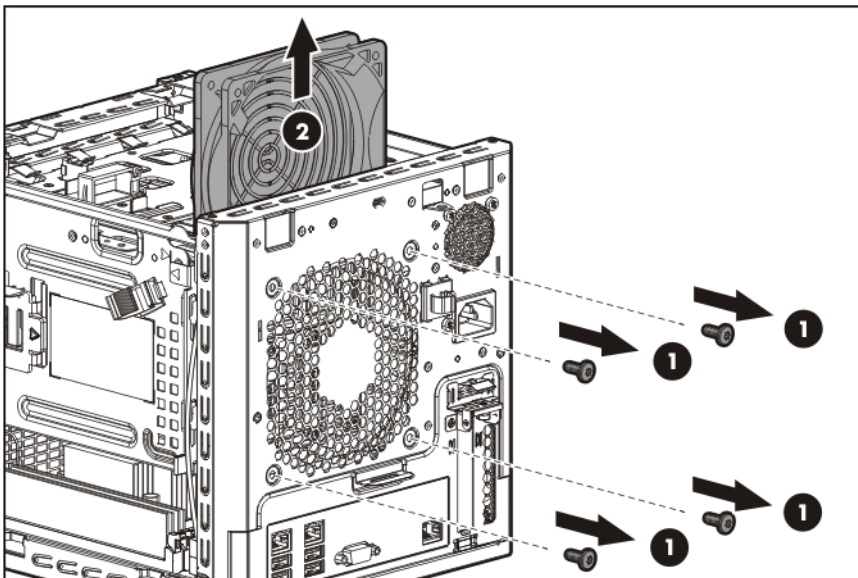
To replace the component, reverse the removal procedure.

Integrated power supply

> ⚠️ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.
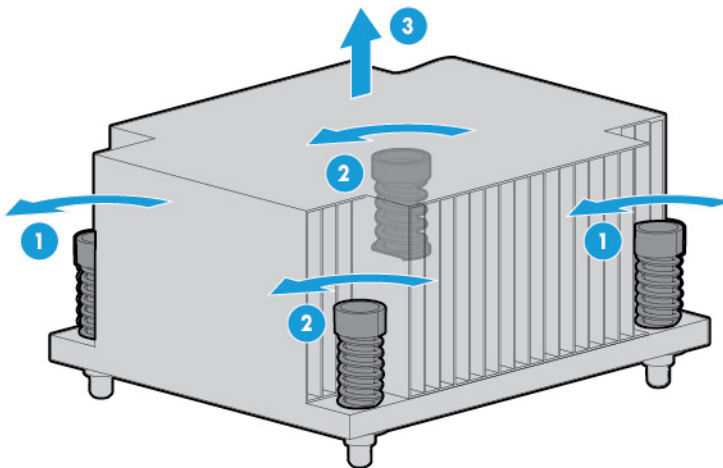
To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. If installed, remove the optical drive ("Optical drive" on page 34).
6. Disconnect all power supply cables:

   a. Disconnect the PSU P1 cable from the system board, and then release it from the left-side chassis cable clip.

   b. If installed, remove the optical drive ("Optical drive" on page 34).

   c. Disconnect the PSU P3 cable from the 4-pin optical drive power cable.

   d. Disconnect the PSU P2 cable from the 4-pin drive power cable.
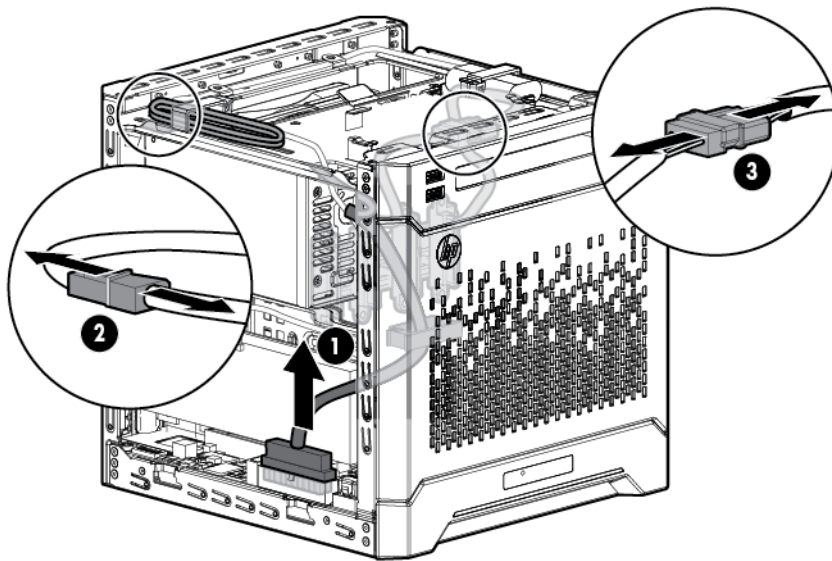
7. Remove the power supply.

   a. Remove the three screws from the rear side of the power supply.

   b. Remove the one screw from the front side of the power supply.

c. Remove the power supply.

To replace the component, reverse the removal procedure.

Expansion board

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Disconnect all cables connected to the expansion board.
6. To open the expansion slot cover retainer latch, press it.
7. If the expansion board is secured with a screw, remove the screw.

8. Remove the expansion board.

To replace the component, reverse the removal procedure.

DIMMs

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Open the DIMM slot latches.
6. Remove the DIMM.

To replace the component, reverse the removal procedure.

Heatsink

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Remove the system board assembly (on page 29).

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the heatsink to cool before touching it.

⚠ **CAUTION:** Heatsink retaining screws should be tightened or loosened in diagonally opposite pairs (in an "X" pattern). Do not overtighten the screws as this can damage the board, connectors, or screws. Use the wrench supplied with the system to reduce the possibility of overtightening the screws.

6. Remove the heatsink:

    a. Loosen one pair of diagonally opposite screws halfway, and then loosen the other pair of screws.
    b. Completely loosen all screws in the same sequence.
    c. Remove the heatsink from the processor backplate.
        — Removing the heatsink for processors with a TDP of 35 W and below

— Removing the heatsink for processors with a TDP higher than 35 W
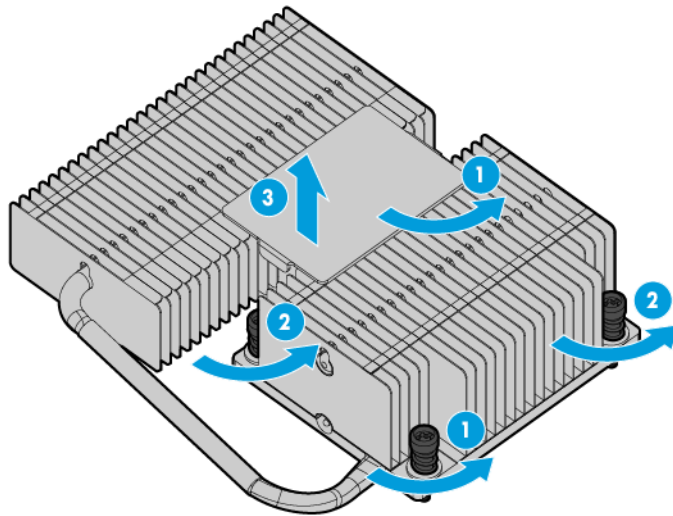
To replace the component:

1. Clean the old thermal grease from the processor with the alcohol swab. Allow the alcohol to evaporate before continuing.

2. Remove the thermal interface protective cover from the heatsink.

   o Removing the thermal interface protective cover from the heatsink for processors with a TDP of 35 W and below
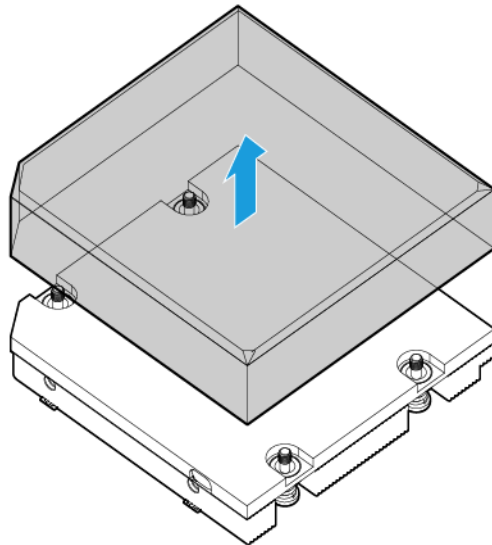
o   Removing the thermal interface protective cover from the heatsink for processors with a TDP higher than 35 W
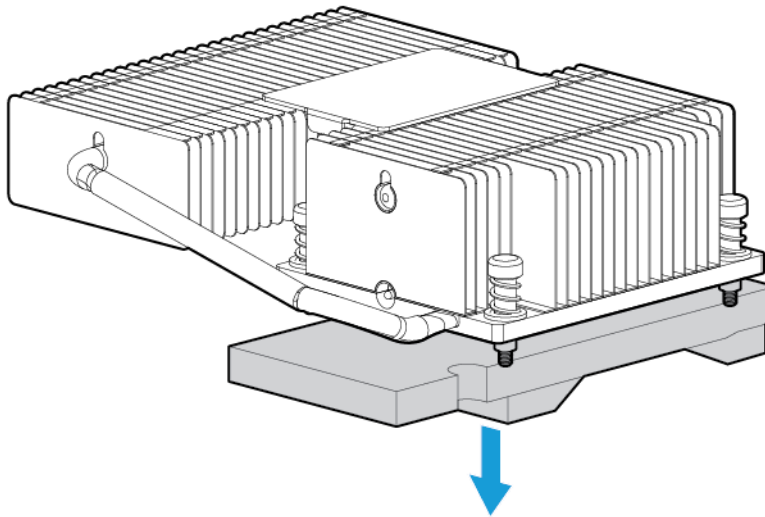
⚠ **CAUTION:**   Heatsink retaining screws should be tightened or loosened in diagonally opposite pairs (in an "X" pattern). Do not overtighten the screws as this can damage the board, connectors, or screws. Use the wrench supplied with the system to reduce the possibility of overtightening the screws.

3.   Install the heatsink:

a.   Position the heatsink on the processor backplate.

b.   Tighten one pair of diagonally opposite screws halfway, and then tighten the other pair of screws.

c.   Finish the installation by completely tightening the screws in the same sequence.

—   Installing the heatsink for processors with a TDP of 35 W and below
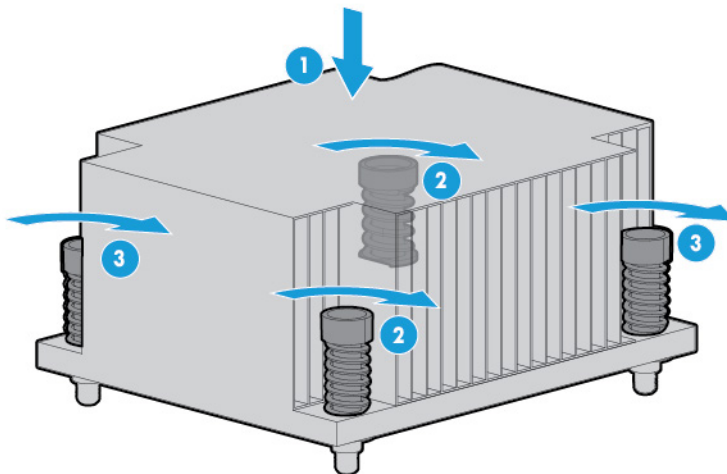
— Installing the heatsink for processors with a TDP higher than 35 W
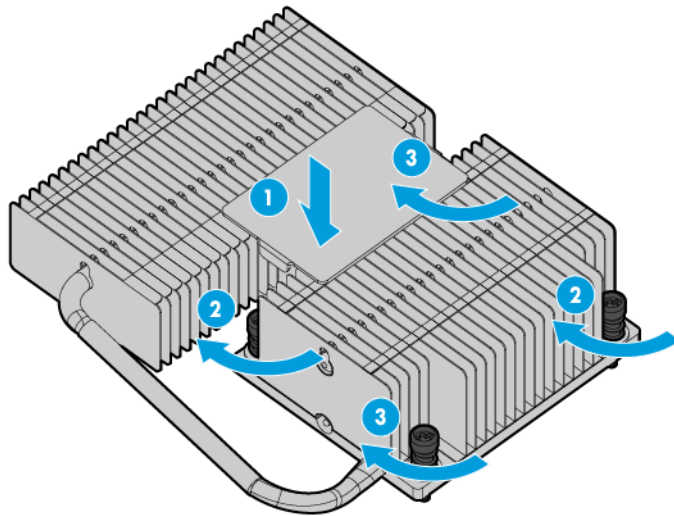
4. Install the system board assembly (on page 31).
5. Install the chassis cover (on page 28).
6. Connect the power cord to the server.
7. Connect the power cord to the AC power source.
8. Press the Power On/Standby button.

   The server exits standby mode and applies full power to the system. The system power LED changes from amber to green.

Processor

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.

⚠ **CAUTION:** To avoid damage to the processor and system board, only authorized personnel should attempt to replace or install the processor in this server.

📝 **IMPORTANT:** If installing a processor with a faster speed, update the system ROM before installing the processor.

To remove the component:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Remove the system board assembly (on page 29).
6. Remove the heatsink ("Heatsink" on page 50).

⚠ **CAUTION:** To avoid damage to the processor, do not touch the bottom of the processor, especially the contact area.

⚠ **CAUTION:** The pins on the processor socket are very fragile. Any damage to them may require replacing the system board.

7. Open the processor locking lever, and then open the processor retaining bracket.

8. Grasp the processor by the edges, and then lift it out of the socket.
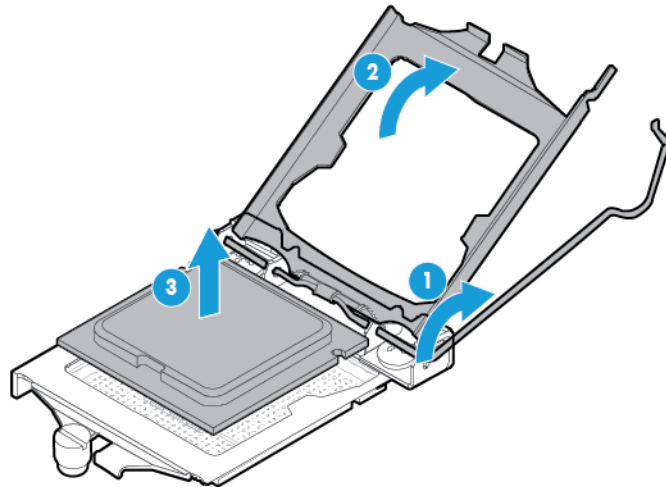
To replace the component:

⚠ **CAUTION:** Failure to completely open the processor locking lever prevents the processor from seating during installation, leading to hardware damage.

⚠ **CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.** To avoid damage to the system board:
   - Do not touch the processor socket contacts.
   - Do not tilt or slide the processor when lowering the processor into the socket.

1. Install the processor. Use the notches on both sides of the processor to properly align it into the socket.
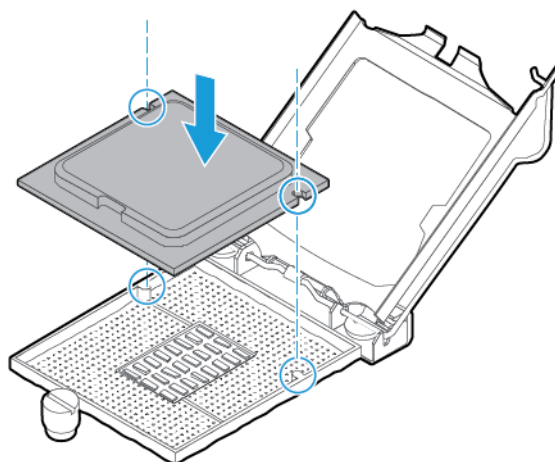
△ **CAUTION:** Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.

2. Close the processor retaining bracket, and then secure the processor locking lever.
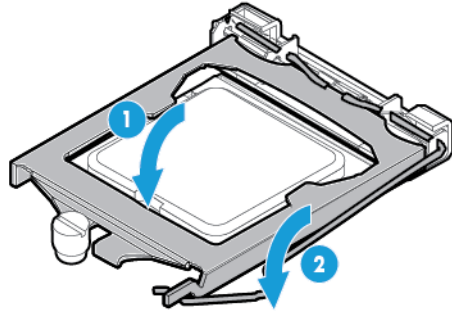
3. Clean the old thermal grease from the heatsink with the alcohol swab. Allow the alcohol to evaporate before continuing.

4. Apply all the grease to the top of the processor in the following pattern to ensure even distribution.
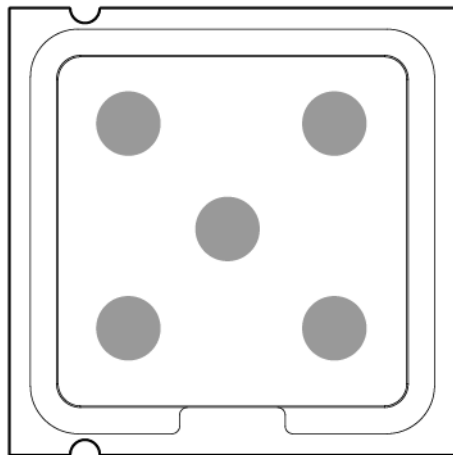
5. Install the heatsink ("Heatsink" on page 50).
6. Install the system board assembly (on page 31).
7. Install the chassis cover (on page 28).
8. Connect each power cord to the server.
9. Connect each power cord to the power source.
10. Press the Power On/Standby button.

    The server exits standby mode and applies full power to the system. The system power LED changes from amber to green.

System board

⚠ **CAUTION:** To avoid ESD damage, when removing electrostatic-sensitive components from the failed system board, place the components on a static-dissipating work surface or inside separate antistatic bags.
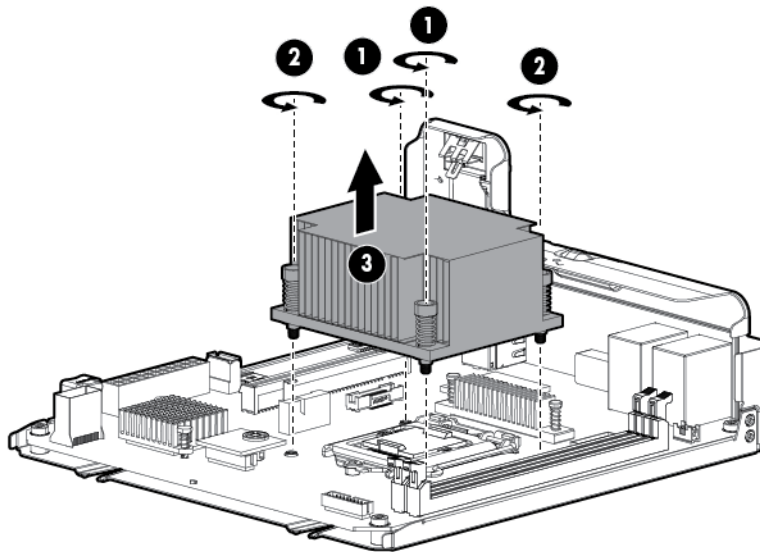
To remove the system board:

1. Power down the server (on page 24).
2. Disconnect the power cord from the AC source.
3. Disconnect the power cord from the server.
4. Remove the chassis cover (on page 27).
5. Remove the system board assembly.

⚠ **WARNING:** To reduce the risk of personal injury from hot surfaces, allow the heatsink to cool before touching it.

⚠ **CAUTION:** Heatsink retaining screws should be tightened or loosened in diagonally opposite pairs (in an "X" pattern). Do not overtighten the screws as this can damage the board, connectors, or screws. Use the wrench supplied with the system to reduce the possibility of overtightening the screws.

6. Remove the heatsink:
   a. Loosen one pair of diagonally opposite screws halfway, and then loosen the other pair of screws.
   b. Completely loosen all screws in the same sequence.
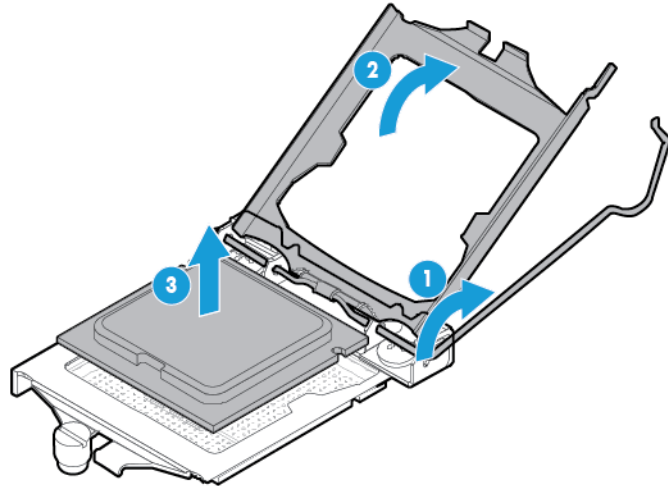   c. Remove the heatsink from the processor backplate.

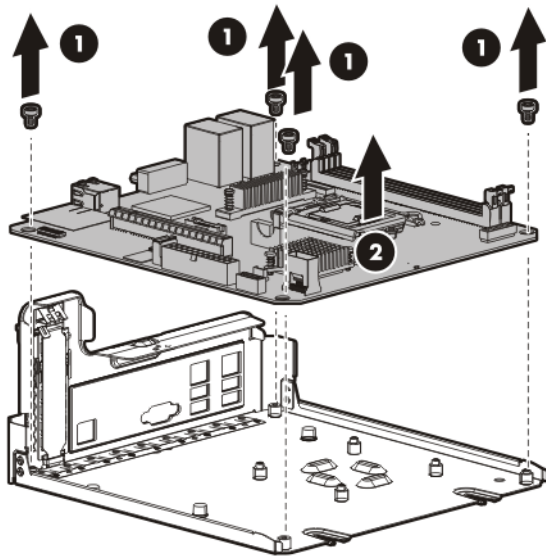⚠ **CAUTION:** To avoid damage to the processor, do not touch the bottom of the processor, especially the contact area.

⚠ **CAUTION:** The pins on the processor socket are very fragile. Any damage to them may require replacing the system board.

7. Open the processor locking lever, and then open the processor retaining bracket.

8. Grasp the processor by the edges, and then lift it out of the socket.
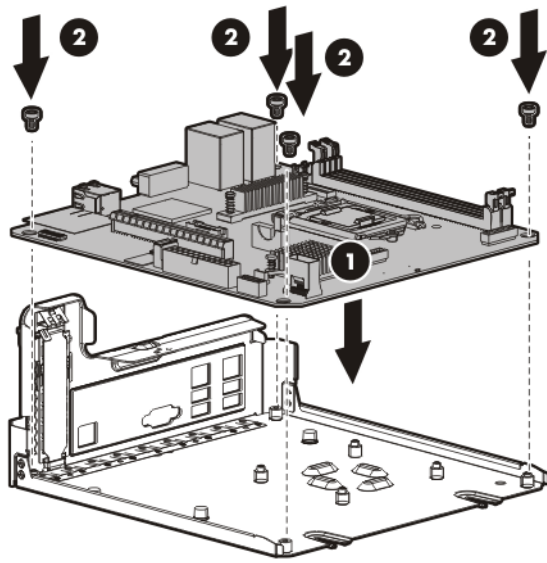

9. Remove all DIMMs ("DIMMs" on page 49).
10. If installed, remove the expansion board ("Expansion board" on page 48).
11. Remove the failed system board.
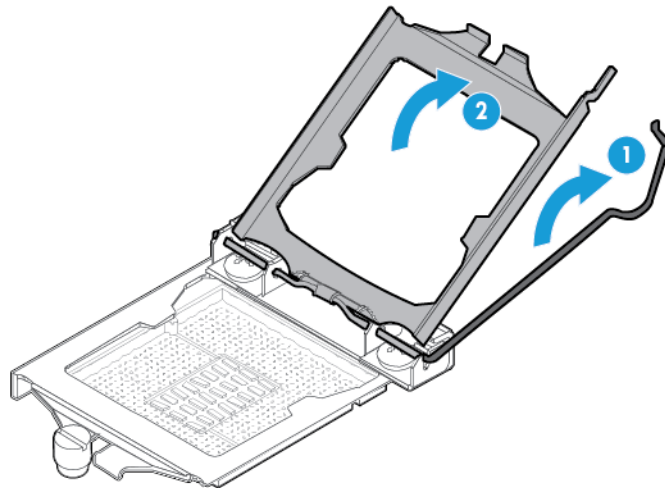
To replace the system board:
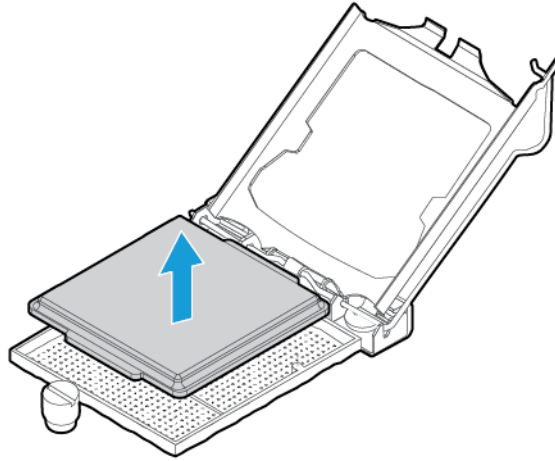
1. Install the system board.

⚠ **CAUTION:** Failure to completely open the processor locking lever prevents the processor from seating during installation, leading to hardware damage.

⚠ **CAUTION:** To avoid damage to the processor, do not touch the bottom of the processor, especially the contact area.

2. Open the processor locking lever, and then open the processor retaining bracket.

3. Remove the processor socket cover.

CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED. To avoid damage to the system board:
- Do not touch the processor socket contacts.
- Do not tilt or slide the processor when lowering the processor into the socket.

4. Install the processor. Use the notches on both sides of the processor to properly align it into the socket.
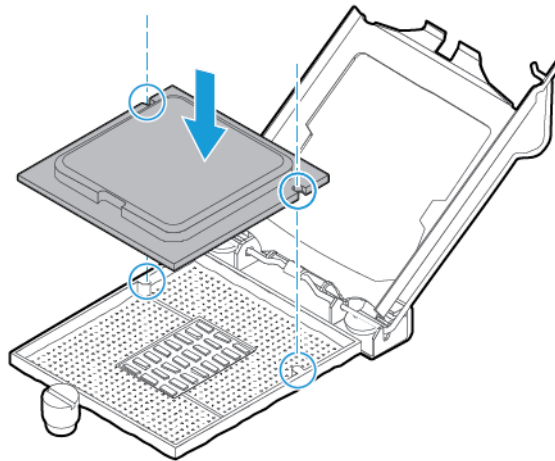
CAUTION: Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.

5. Close the processor retaining bracket, and then secure the processor locking lever.
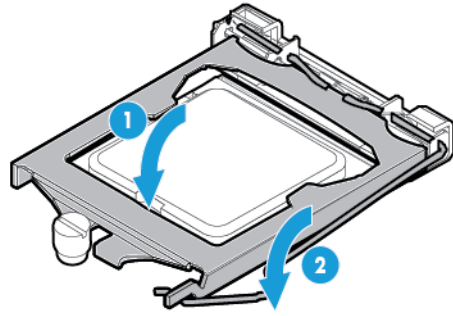

6. Clean the old thermal grease from the heatsink and the top of the processor with the alcohol swab. Allow the alcohol to evaporate before continuing.

7. Apply all the grease to the top of the processor in the following pattern to ensure even distribution.
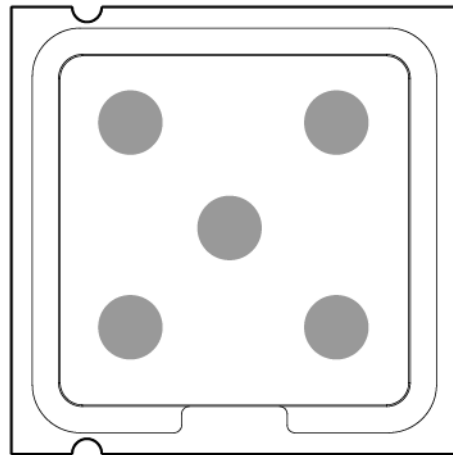
⚠ **CAUTION:** Heatsink retaining screws should be tightened or loosened in diagonally opposite pairs (in an "X" pattern). Do not overtighten the screws as this can damage the board, connectors, or screws. Use the wrench supplied with the system to reduce the possibility of overtightening the screws.

8. Install the heatsink:

    a. Position the heatsink on the processor backplate.

    b. Tighten one pair of diagonally opposite screws halfway, and then tighten the other pair of screws.

c. Finish the installation by completely tightening the screws in the same sequence.
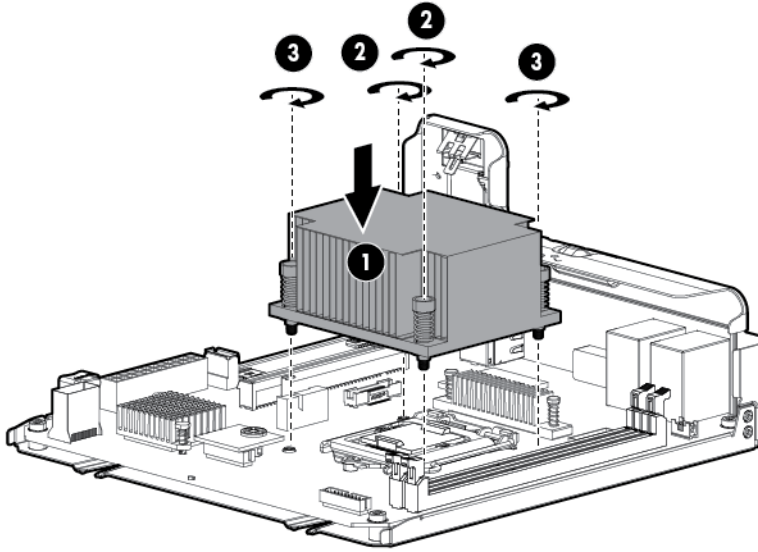
> ⚠ **CAUTION:** When returning a damaged system board to HP, always install all processor socket covers to prevent damage to the processor sockets and system board.

9. Install the processor socket cover on the failed system board.
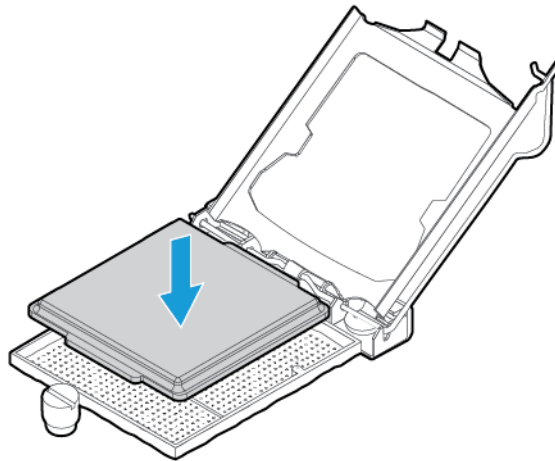
10. Install the system board assembly (on page 31).
11. Install the DIMMs.
12. If removed, install the expansion board.
13. Install the chassis cover (on page 28).
14. Connect the power cord to the server.
15. Connect the power cord to the AC power source.
16. Press the Power On/Standby button.

   The server exits standby mode and applies full power to the system. The system power LED changes from amber to green.

After you replace the system board, you must re-enter the server serial number and the product ID.

1. During the server startup sequence, press the **F9** key to access RBSU.

2. Select the **Advanced Options** menu.

3. Select **Service Options**.

4. Select **Serial Number**. The following warning appears:

   ```
   Warning: The serial number should ONLY be modified by qualified service
   personnel. This value should always match the serial number located on the
   chassis.
   ```

5. Press the **Enter** key to clear the warning.

6. Enter the serial number and press the **Enter** key.

7. Select **Product ID**. The following warning appears:

   ```
   Warning: The Product ID should ONLY be modified by qualified service
   personnel. This value should always match the Product ID located on the
   chassis.
   ```

8. Enter the product ID and press the **Enter** key.

9. Press the **Esc** key to close the menu.

10. Press the **Esc** key to exit RBSU.

11. Press the **F10** key to confirm exiting RBSU. The server automatically reboots.

System battery

If the server no longer automatically displays the correct date and time, then replace the battery that provides power to the real-time clock. Under normal use, battery life is 5 to 10 years.

> ⚠ **WARNING:**   The computer contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery pack. A risk of fire and burns exists if the battery pack is not properly handled. To reduce the risk of personal injury:
> - Do not attempt to recharge the battery.
> - Do not expose the battery to temperatures higher than 60°C (140°F).
> - Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.
> - Replace only with the spare designated for this product.

To remove the component:

1. Power down the server (on page 24).

2. Disconnect the power cord from the AC source.

3. Disconnect the power cord from the server.

4. Remove the chassis cover (on page 27).

5. If installed, remove the expansion board ("Expansion board" on page 48).

6. Locate the battery on the system board ("System board components" on page 74).

7. Remove the battery.
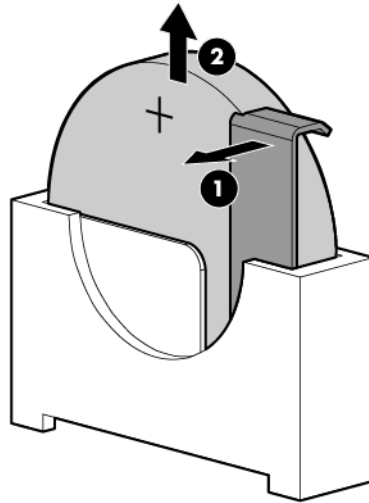
📝 **IMPORTANT:** Replacing the system board battery resets the system ROM to its default configuration. After replacing the battery, reconfigure the system through RBSU.

To replace the component, reverse the removal procedure.

For more information about battery replacement or proper disposal, contact an authorized reseller or an authorized service provider.

HP Trusted Platform Module

The TPM is not a customer-removable part.

⚠ **CAUTION:** Any attempt to remove an installed TPM from the system board breaks or disfigures the TPM security rivet. Upon locating a broken or disfigured rivet on an installed TPM, administrators should consider the system compromised and take appropriate measures to ensure the integrity of the system data.

If you suspect a TPM board failure, leave the TPM installed and remove the system board ("Remove the system board assembly" on page 29). Contact an HP authorized service provider for a replacement system board and TPM board.

Troubleshooting

Troubleshooting resources

The *HP ProLiant Gen8 Troubleshooting Guide, Volume I: Troubleshooting* provides procedures for resolving common problems and comprehensive courses of action for fault isolation and identification, issue resolution, and software maintenance on ProLiant servers and server blades. To view the guide, select a language:

- English (http://www.hp.com/support/ProLiant_TSG_v1_en)
- French (http://www.hp.com/support/ProLiant_TSG_v1_fr)
- Spanish (http://www.hp.com/support/ProLiant_TSG_v1_sp)
- German (http://www.hp.com/support/ProLiant_TSG_v1_gr)
- Japanese (http://www.hp.com/support/ProLiant_TSG_v1_jp)
- Simplified Chinese (http://www.hp.com/support/ProLiant_TSG_v1_sc)

The *HP ProLiant Gen8 Troubleshooting Guide, Volume II: Error Messages* provides a list of error messages and information to assist with interpreting and resolving error messages on ProLiant servers and server blades. To view the guide, select a language:

- English (http://www.hp.com/support/ProLiant_EMG_v1_en)
- French (http://www.hp.com/support/ProLiant_EMG_v1_fr)
- Spanish (http://www.hp.com/support/ProLiant_EMG_v1_sp)
- German (http://www.hp.com/support/ProLiant_EMG_v1_gr)
- Japanese (http://www.hp.com/support/ProLiant_EMG_v1_jp)
- Simplified Chinese (http://www.hp.com/support/ProLiant_EMG_v1_sc)

Diagnostic tools

Product QuickSpecs

For more information about product features, specifications, options, configurations, and compatibility, see the product QuickSpecs on the HP website (http://www.hp.com/go/qs).

HP iLO

The iLO 4 subsystem is a standard component of HP ProLiant servers that simplifies initial server setup, server health monitoring, power and thermal optimization, and remote server administration. The iLO 4 subsystem includes an intelligent microprocessor, secure memory, and a dedicated network interface. This design makes iLO 4 independent of the host server and its operating system.

iLO 4 enables and manages the Active Health System (on page 65) and also features Agentless Management. All key internal subsystems are monitored by iLO 4. If enabled, SNMP alerts are sent directly by iLO 4 regardless of the host operating system or even if no host operating system is installed.

Embedded remote support software is available on HP ProLiant Gen8 and later servers with iLO 4, regardless of the operating system software and without installing OS agents on the server.

Using iLO 4, you can do the following:

- Access a high-performance and secure Integrated Remote Console to the server from anywhere in the world if you have a network connection to the server.
- Use the shared .NET Integrated Remote Console to collaborate with up to four server administrators.
- Remotely mount high-performance Virtual Media devices to the server.
- Securely and remotely control the power state of the managed server.
- Implement true Agentless Management with SNMP alerts from HP iLO, regardless of the state of the host server.
- Download the Active Health System log.
- Register for HP Insight Remote Support.
- Use iLO Federation to manage multiple servers from one system running the iLO web interface.
- Use Virtual Power and Virtual Media from the GUI, the CLI, or the iLO scripting toolkit for many tasks, including the automation of deployment and provisioning.
- Control iLO by using a remote management tool.

For more information about iLO 4 features, see the iLO 4 documentation on the HP website (http://www.hp.com/go/ilo/docs).

Active Health System

HP Active Health System provides the following features:

- Combined diagnostics tools/scanners
- Always on, continuous monitoring for increased stability and shorter downtimes
- Rich configuration history
- Health and service alerts
- Easy export and upload to Service and Support

The HP Active Health System monitors and records changes in the server hardware and system configuration. The Active Health System assists in diagnosing problems and delivering rapid resolution if server failures occur.

The Active Health System collects the following types of data:

- Server model
- Serial number
- Processor model and speed
- Storage capacity and speed
- Memory capacity and speed
- Firmware/BIOS

HP Active Health System does not collect information about Active Health System users' operations, finances, customers, employees, partners, or data center, such as IP addresses, host names, user names, and passwords. HP Active Health System does not parse or change operating system data from third-party error event log activities, such as content created or passed through by the operating system.

The data that is collected is managed according to the HP Data Privacy policy. For more information see the HP website (http://www.hp.com/go/privacy).

The Active Health System, in conjunction with the system monitoring provided by Agentless Management or SNMP Pass-thru, provides continuous monitoring of hardware and configuration changes, system status, and service alerts for various server components.

The Agentless Management Service is available in the SPP, which can be downloaded from the HP website (http://www.hp.com/go/spp/download). The Active Health System log can be downloaded manually from iLO 4 or HP Intelligent Provisioning and sent to HP.

For more information, see the following documents:

- *HP iLO User Guide* on the HP website (http://www.hp.com/go/ilo/docs)
- *HP Intelligent Provisioning User Guide* on the HP website (http://www.hp.com/go/intelligentprovisioning/docs)

Integrated Management Log

The IML records hundreds of events and stores them in an easy-to-view form. The IML timestamps each event with 1-minute granularity.

You can view recorded events in the IML in several ways, including the following:

- From within HP SIM
- From within operating system-specific IML viewers:
    - For Windows: IML Viewer

- o   For Linux: IML Viewer Application
- From within the iLO 4 web interface
- From within HP Insight Diagnostics (on page)

HP Insight Remote Support

HP strongly recommends that you register your device for remote support to enable enhanced delivery of your HP Warranty, HP Care Pack Service, or HP contractual support agreement. HP Insight Remote Support supplements your monitoring continuously to ensure maximum system availability by providing intelligent event diagnosis, and automatic, secure submission of hardware event notifications to HP, which will initiate a fast and accurate resolution, based on your product's service level. Notifications can be sent to your authorized HP Channel Partner for onsite service, if configured and available in your country.

For more information, see *HP Insight Remote Support and Insight Online Setup Guide for ProLiant Servers and BladeSystem c-Class Enclosures* on the HP website (http://www.hp.com/go/insightremotesupport/docs). HP Insight Remote Support is available as part of HP Warranty, HP Care Pack Service, or HP contractual support agreement.

HP Insight Diagnostics

HP Insight Diagnostics is a proactive server management tool, available in both offline and online versions, that provides diagnostics and troubleshooting capabilities to assist IT administrators who verify server installations, troubleshoot problems, and perform repair validation.

HP Insight Diagnostics Offline Edition performs various in-depth system and component testing while the OS is not running. To run this utility, boot the server using Intelligent Provisioning.

HP Insight Diagnostics Online Edition is a web-based application that captures system configuration and other related data needed for effective server management. Available in Microsoft Windows and Linux versions, the utility helps to ensure proper system operation.

For more information or to download the utility, see the HP website (http://www.hp.com/servers/diags). HP Insight Diagnostics Online Edition is also available in the SPP.

HP Insight Diagnostics survey functionality

HP Insight Diagnostics (on page) provides survey functionality that gathers critical hardware and software information on ProLiant servers.

This functionality supports operating systems that are supported by the server. For operating systems supported by the server, see the HP website (http://www.hp.com/go/supportos).

If a significant change occurs between data-gathering intervals, the survey function marks the previous information and overwrites the survey data files to reflect the latest changes in the configuration.

Survey functionality is installed with every Intelligent Provisioning-assisted HP Insight Diagnostics installation, or it can be installed through the SPP.

HP ROM-Based Setup Utility

RBSU is a configuration utility embedded in HP ProLiant servers that performs a wide range of configuration activities that can include the following:

- Configuring system devices and installed options
- Enabling and disabling system features
- Displaying system information
- Selecting the primary boot controller
- Configuring memory options
- Language selection

For more information on RBSU, see the *HP ROM-Based Setup Utility User Guide* on the HP RBSU Information Library (http://www.hp.com/go/rbsu/docs).

Using RBSU

To use RBSU, use the following keys:

- To access RBSU, press the **F9** key during power-up when prompted.
- To navigate the menu system, use the arrow keys.
- To make selections, press the **Enter** key.
- To access Help for a highlighted configuration option, press the **F1** key.

> **IMPORTANT:**   RBSU automatically saves settings when you press the **Enter** key. The utility does not prompt you for confirmation of settings before you exit the utility. To change a selected setting, you must select a different setting and press the **Enter** key.

Default configuration settings are applied to the server at one of the following times:

- Upon the first system power-up
- After defaults have been restored

Default configuration settings are sufficient for proper typical server operation, but configuration settings can be modified using RBSU. The system will prompt you for access to RBSU with each power-up.

Re-entering the server serial number and product ID

After you replace the system board, you must re-enter the server serial number and the product ID.

1.   During the server startup sequence, press the **F9** key to access RBSU.
2.   Select the **Advanced Options** menu.
3.   Select **Service Options**.
4.   Select **Serial Number**. The following warning appears:

```
Warning: The serial number should ONLY be modified by qualified service
personnel. This value should always match the serial number located on the
chassis.
```

5.   Press the **Enter** key to clear the warning.
6.   Enter the serial number and press the **Enter** key.
7.   Select **Product ID**. The following warning appears:

```
Warning: The Product ID should ONLY be modified by qualified service
personnel. This value should always match the Product ID located on the
chassis.
```

8. Enter the product ID and press the **Enter** key.

9. Press the **Esc** key to close the menu.

10. Press the **Esc** key to exit RBSU.

11. Press the **F10** key to confirm exiting RBSU. The server automatically reboots.

Utilities and features

HP Smart Storage Administrator

HP SSA is a configuration and management tool for HP Smart Array controllers. Starting with HP ProLiant Gen8 servers, HP SSA replaces ACU with an enhanced GUI and additional configuration features.

HP SSA exists in three interface formats: the HP SSA GUI, the HP SSA CLI, and HP SSA Scripting. Although all formats provide support for configuration tasks, some of the advanced tasks are available in only one format.

Some HP SSA features include the following:

- Supports online array capacity expansion, logical drive extension, assignment of online spares, and RAID or stripe size migration

- Suggests the optimal configuration for an unconfigured system

- Provides diagnostic and SmartSSD Wear Gauge functionality on the Diagnostics tab

- For supported controllers, provides access to additional features.

For more information about HP SSA, see the HP website (http://www.hp.com/go/hpssa).

Automatic Server Recovery

ASR is a feature that causes the system to restart when a catastrophic operating system error occurs, such as a blue screen, ABEND (does not apply to HP ProLiant DL980 Servers), or panic. A system fail-safe timer, the ASR timer, starts when the System Management driver, also known as the Health Driver, is loaded. When the operating system is functioning properly, the system periodically resets the timer. However, when the operating system fails, the timer expires and restarts the server.

ASR increases server availability by restarting the server within a specified time after a system hang. At the same time, the HP SIM console notifies you by sending a message to a designated pager number that ASR has restarted the system. You can disable ASR from the System Management Homepage or through RBSU.

USB support

HP provides standard USB 2.0 support, standard USB 3.0 support, and legacy USB support. Standard support is provided by the OS through the appropriate USB device drivers.

Before the OS loads, HP provides support for USB 2.0 devices through legacy USB support, which is enabled by default in the system ROM. USB 3.0 ports are not functional before the OS loads. The native OS provides USB 3.0 support through appropriate xHCI drivers.

Legacy USB support provides USB functionality in environments where USB support is not available normally. Specifically, HP provides legacy USB functionality for the following:

- POST

- RBSU
- Diagnostics
- DOS
- Operating environments which do not provide native USB support

External USB functionality

HP provides external USB support to enable local connection of USB devices for server administration, configuration, and diagnostic procedures.

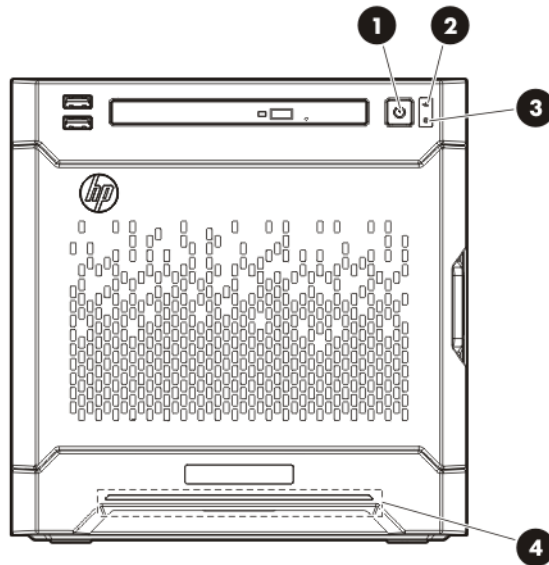For additional security, external USB functionality can be disabled through RBSU.

Component identification

Front panel components
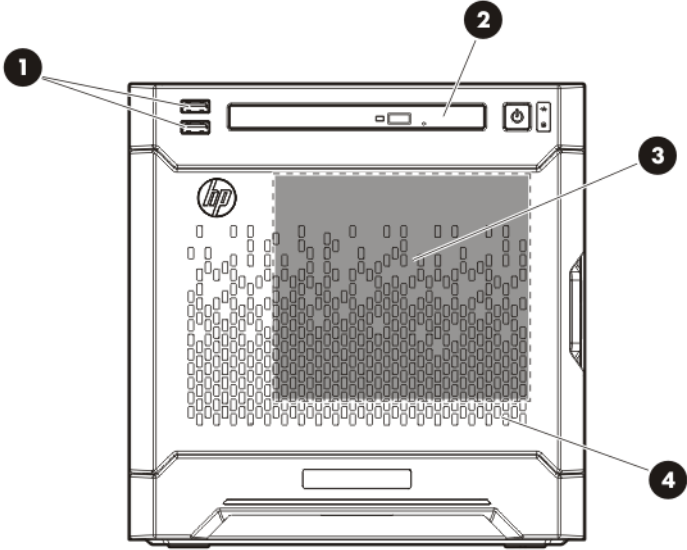
Item	Description
1	USB 2.0 connectors
2	Optical drive (optional)
3	Drive bays (inside)
4	Front bezel

Front panel LEDs and buttons

Item	Description	Status
1	Power On/Standby button and system power LED	Solid green = System on Flashing green (1 Hz/cycle per sec) = Performing power on sequence Solid amber = System in standby Off = No power present*
2	NIC status LED	Solid green = Link to network Flashing green (1 Hz/cycle per sec) = Network active Off = No network activity
3	Drive status LED	Solid green = System on Flashing green = Drive activity Off = System in standby or no power present
4	Health LED	Solid blue = Normal Flashing amber = System degraded Flashing red (1 Hz/cycle per sec) = System critical Fast-flashing red (4 Hz/cycles per sec) = Power fault**

* Facility power is not present, power cord is not attached, no power supplies are installed, power supply failure has occurred, or the power button cable is disconnected.
** To identify components in a degraded or critical state, see the iLO/BIOS logs and the server troubleshooting guide.

Rear panel components
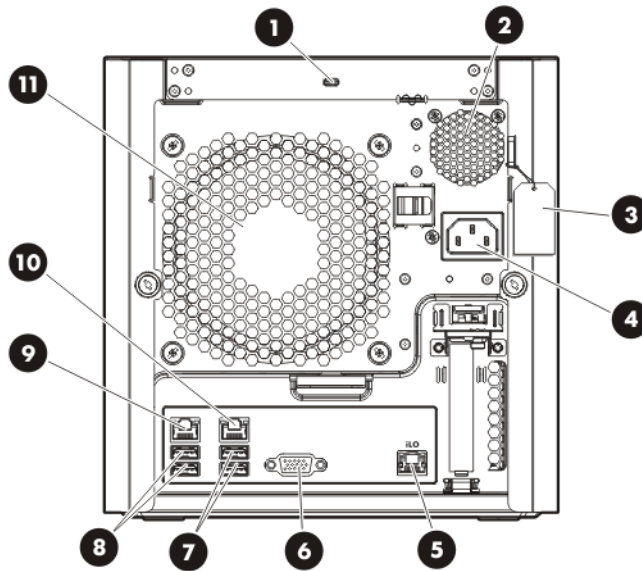
Item	Description
1	Kensington security slot
2	Power supply
3	Serial number/iLO information tag*
4	Power cord connector
5	Dedicated iLO 4 connector
6	Video connector
7	USB 3.0 connectors
8	USB 2.0 connectors
9	NIC connector 2
10	NIC connector 1/shared iLO 4 connector
11	System fan

* The serial number/iLO information tag shows the server serial number and the default iLO account information. The same information is printed on separate labels located on the rear panel.

Rear panel LEDs and buttons
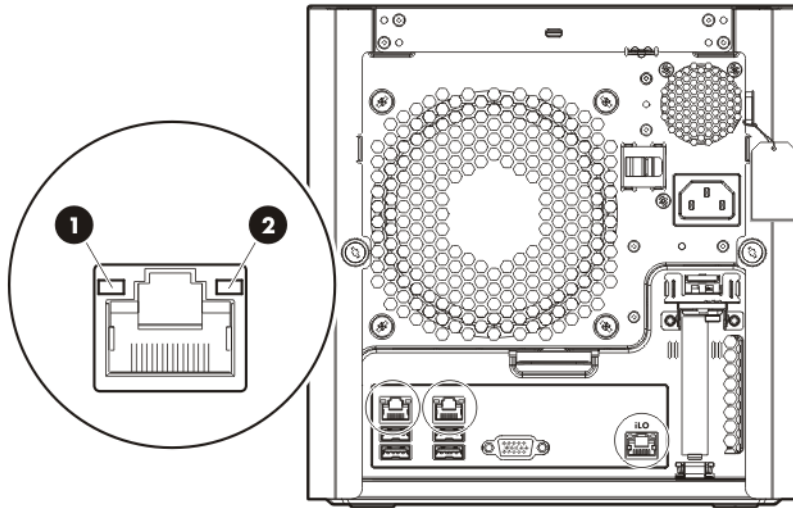
Item	Description	Status
1	NIC link LED	Solid green = Link exists Off = No link exists
2	NIC status LED	Solid green = Link to network Flashing green (1 Hz/cycle per sec) = Network active Off = No network activity

System board components
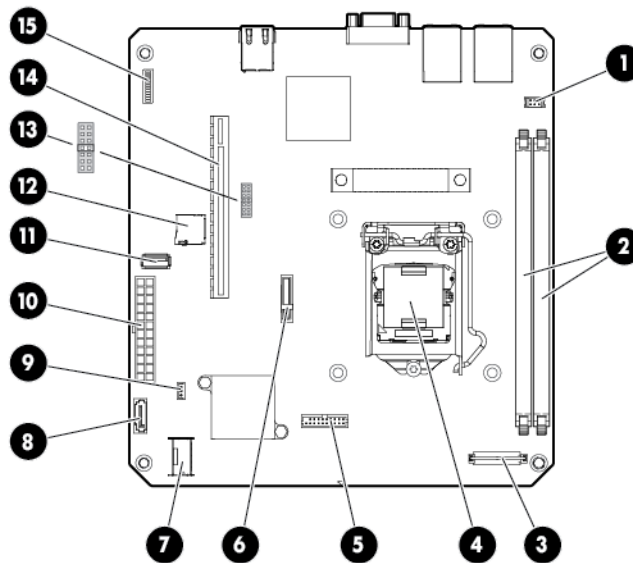
Item	Description
1	Fan connector
2	DIMM slots
3	Front I/O connector
4	Processor socket
5	TPM connector
6	System battery
7	Mini-SAS connector
8	Optical drive SATA connector
9	Ambient temperature sensor connector
10	24-pin system board power connector
11	Internal USB 2.0 connector
12	microSD card slot
13	NMI header
14	PCIe2 x16 (8, 4, 1) slot
15	System maintenance switch

PCIe slot description

PCIe2 x16 (8,4,1)

— Negotiable link width(s)

— Physical connector link width

— Gen 2 signaling rate
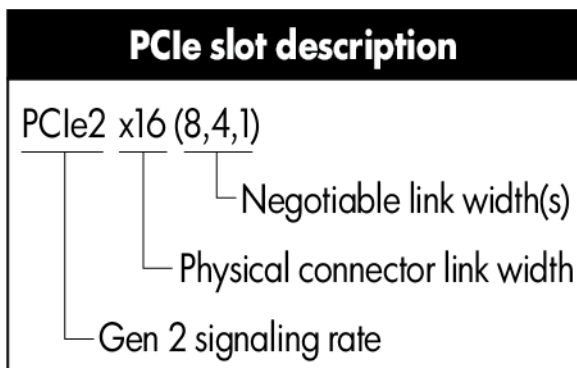
DIMM slot locations

DIMM slots are numbered 1 and 2. The supported AMP modes use the letter assignments for population guidelines.
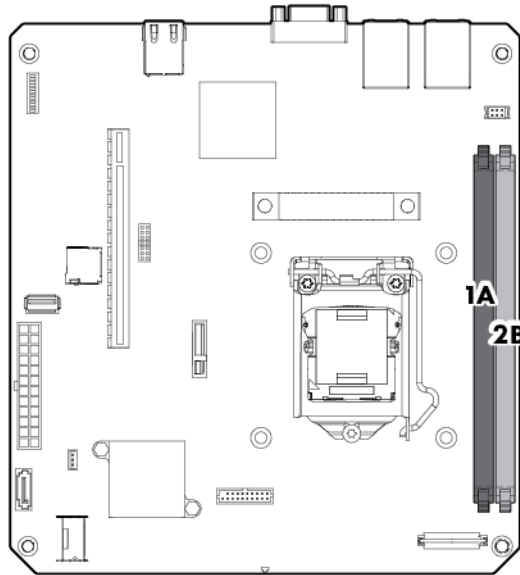
System maintenance switch

Position	Default	Function
S1	Off	Off = iLO 4 security is enabled. On = iLO 4 security is disabled.
S2	Off	Off = System configuration can be changed. On = System configuration is locked.
S3	Off	Reserved
S4	Off	Reserved
S5	Off	Off = Power-on password is enabled. On = Power-on password is disabled.
S6	Off	Off = No function On = ROM reads system configuration as invalid.
S7	—	Reserved
S8	—	Reserved
S9	—	Reserved
S10	—	Reserved
S11	—	Reserved
S12	—	Reserved

To access the redundant ROM, set S1, S5, and S6 to on.

When the system maintenance switch position 6 is set to the On position, the system is prepared to erase all system configuration settings from both CMOS and NVRAM.

> **△ CAUTION:** Clearing CMOS and/or NVRAM deletes configuration information. Be sure to properly configure the server or data loss could occur.

NMI functionality

An NMI crash dump creates a crash dump log before resetting a system which is not responding.

Crash dump log analysis is an essential part of diagnosing reliability problems, such as failures of operating systems, device drivers, and applications. Many crashes freeze a system, and the only available action for administrators is to restart the system. Resetting the system erases any information which could support problem analysis, but the NMI feature preserves that information by performing a memory dump before a system reset.

To force the system to invoke the NMI handler and generate a crash dump log, do one of the following:

- Use the iLO Virtual NMI feature.
- Short the NMI header ("System board components" on page 74).

For more information, see the HP website (http://www.hp.com/support/NMI).

Drive numbering

The server supports four LFF non-hot-plug SATA drives.
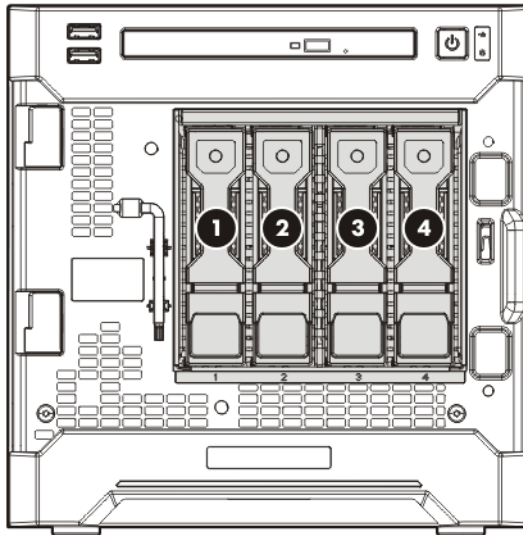
Fan location

The server has one system fan located at the rear of the server.
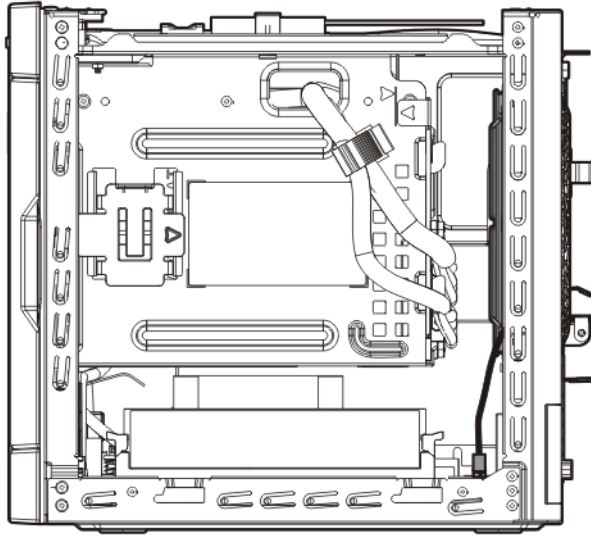
L-wrench

The server includes an L-wrench located on the front panel. The long end is for a Phillips #2 screw head and the short one is for T-15 screw head. Use this L-wrench to loosen screws during hardware configuration procedures.
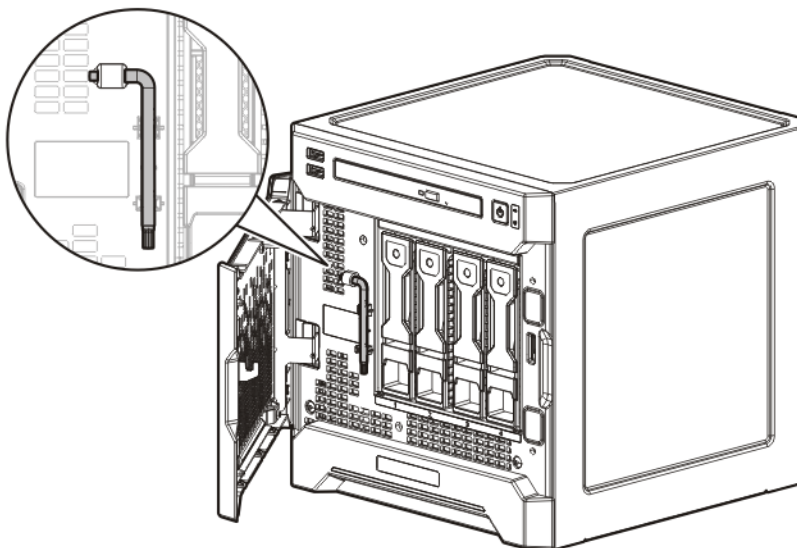
Cabling

Cabling overview

This section provides guidelines that help you make informed decisions about cabling the server and hardware options to optimize performance.

For information on cabling peripheral components, refer to the white paper on high-density deployment at the HP website (http://www.hp.com/products/servers/platforms).

⚠ **CAUTION:** When routing cables, always be sure that the cables are not in a position where they can be pinched or crimped.

Four-bay LFF non-hot-plug drive cabling

The four-bay LFF non-hot-plug drive cable assembly consists of the drive power and Mini-SAS cables attached to a bracket. If either the drive power or Mini-SAS cable becomes defective, the entire cable assembly will need to be replaced (spare PN: 724493-001).

• Mini-SAS cable connected to the system board
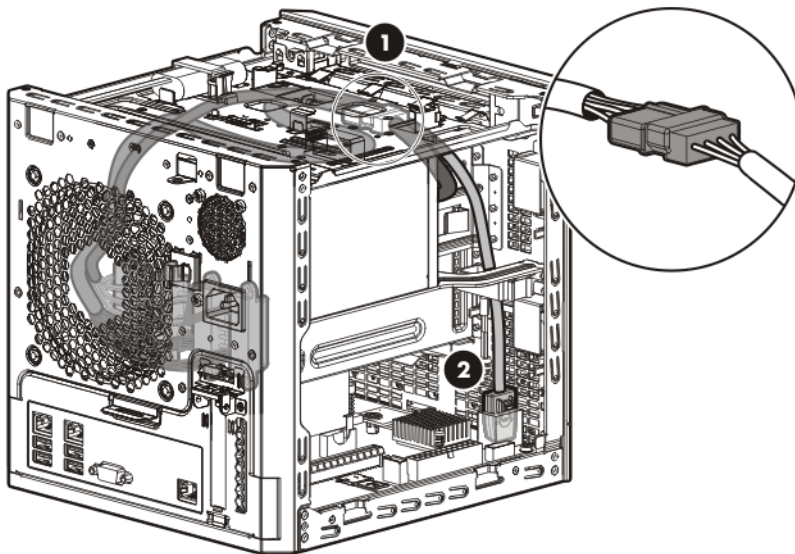
Item	Description
1	4-pin power cable (connected to the PSU P2 cable)
2	Mini-SAS cable

- Mini-SAS cable connected to controller board
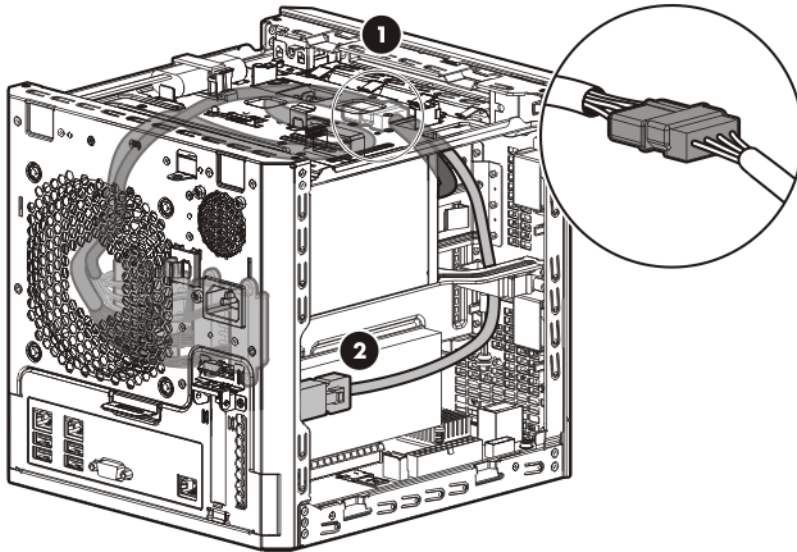
Item	Description
1	4-pin power cable (connected to the PSU P2 cable)
2	Mini-SAS cable

Capacitor pack cabling
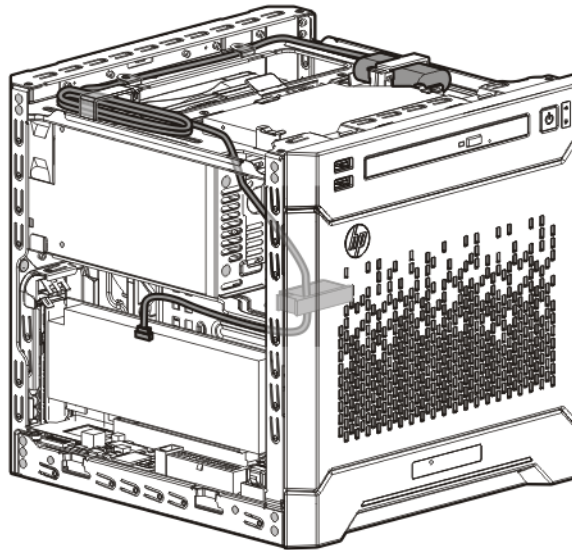
Optical drive cabling
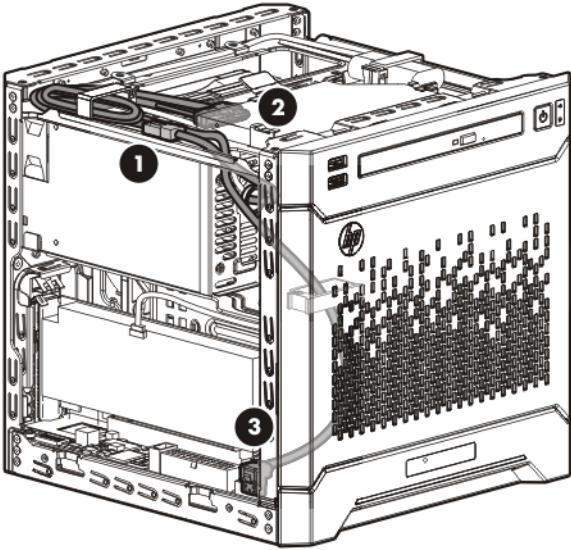
Item	Description
1	4-pin power connector (connected to the PSU P3 cable) of the optical drive SATA Y-cable
2	Common end of the optical drive SATA Y-cable
3	SATA connector of the optical drive SATA Y-cable

Front I/O assembly cabling
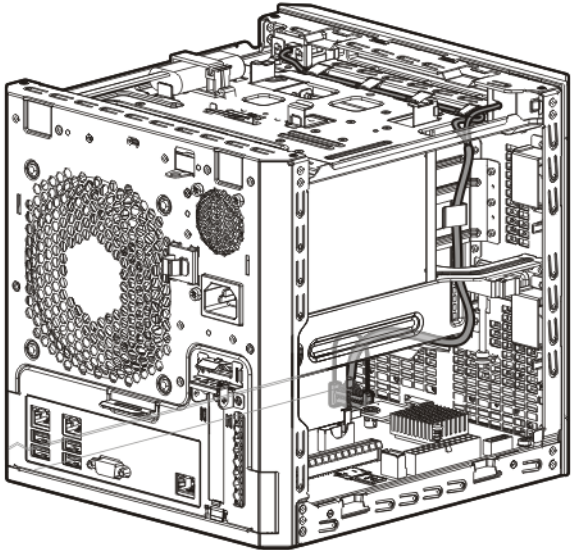
Ambient temperature sensor cabling
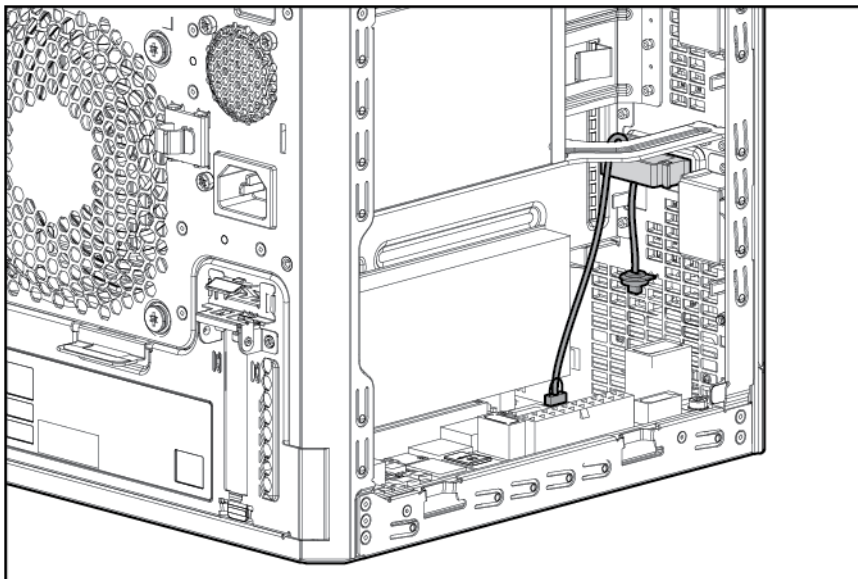
System fan cabling
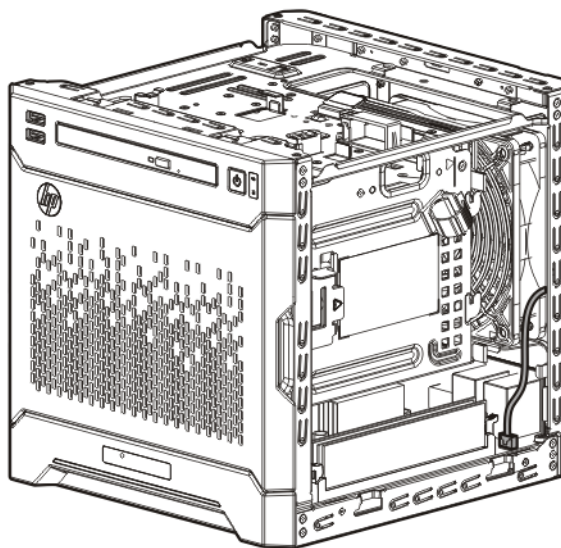
Power supply cabling
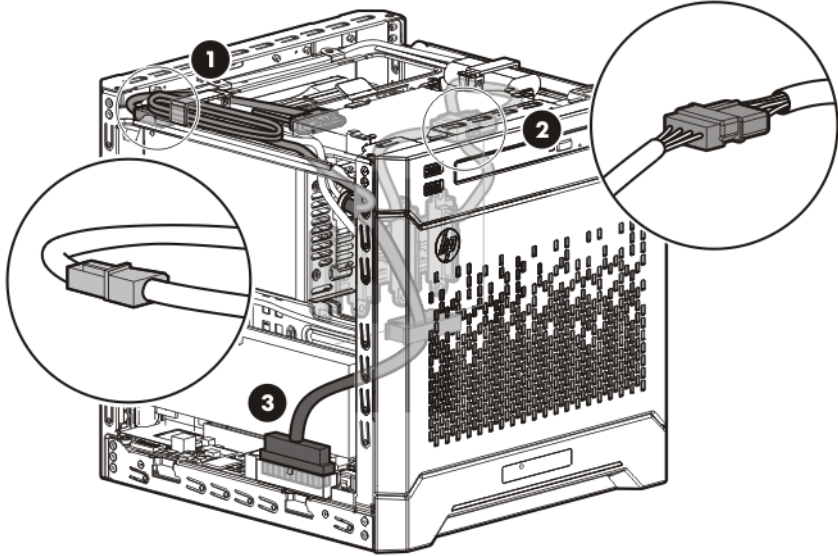
Item	PSU cable marker	Description
1	P3	4-pin optical drive power cable
2	P2	4-pin drive power cable
3	P1	24-pin system board power cable

Specifications

Environmental specifications

Specification	Value
Temperature range*	
Operating	10°C to 35°C (50°F to 95°F)
Non-operating	-30°C to 60°C (-22°F to 140°F)
Relative humidity (non-condensing)	
Operating, maximum wet bulb temperature of 28°C (82.4°F)	10% to 90%
Non-operating, maximum wet bulb temperature of 38.7°C (101.7°F)	5% to 95%

* All temperature ratings shown are for sea level. An altitude derating of 1°C per 304.8 m (1.8°F per 1,000 ft) to 3048 m (10,000 ft) is applicable. No direct sunlight allowed.

Server specifications

Specification	Value
Height	23.25 cm (9.15 in)
Depth	24.50 cm (9.65 in)
Width	23.00 cm (9.06 in)
Weight, minimum (one drive, power supply, and processor installed)	7.40 kg (16.31 lb)
Weight, maximum (all drives, power supply, and processor installed)	9.80 kg (21.60 lb)

Power supply specifications

Depending on the installed options and/or the regional location where the server was purchased, the server is configured with one of the following power supplies:

- HP 150 W Integrated Power Supply (non-hot-plug, non-redundant) ("HP 150 W Integrated Power Supply specifications" on page 85)

- HP 200 W Integrated Power Supply (non-hot-plug, non-redundant) ("HP 200 W Integrated Power Supply specifications" on page 85)

HP 150 W Integrated Power Supply specifications

Specification	Value
Input requirements	—
Rated input voltage	100 V AC to 240 V AC
Rated input frequency	50 Hz to 63 Hz
Rated input current	3.5 A at 100 V AC
Rated input power	< 192W at 100 V AC < 185 W at 200 V AC
Efficiency (minimum)	79%
Power supply output	—
Rated steady-state power	150 W at 100 V AC 150 W at 200 V AC
Maximum peak power	150 W at 100 V AC 150 W at 200 V AC
Rated output power	150 W

HP 200 W Integrated Power Supply specifications

Specification	Value
Input requirements	—
Rated input voltage	100 V AC to 240 V AC
Rated input frequency	50 Hz to 63 Hz
Rated input current	3.5 A at 100 V AC
Rated input power	< 243 W at 100 V AC < 237 W at 200 V AC
Efficiency	81.5%
Power supply output	—
Rated steady-state power	200 W at 100 V AC 200 W at 200 V AC
Maximum peak power	200 W at 100 V AC 200 W at 200 V AC
Rated output power	200 W

Acronyms and abbreviations

ABEND

abnormal end

ACU

Array Configuration Utility

AMP

Advanced Memory Protection

ASR

Automatic Server Recovery

CSR

Customer Self Repair

DDR3

double data rate-3

FBWC

flash-backed write cache

HP SIM

HP Systems Insight Manager

HP SSA

HP Smart Storage Administrator

iLO

Integrated Lights-Out

IML

Integrated Management Log

LFF

large form factor

LOM

Lights-Out Management

NMI

nonmaskable interrupt

NVRAM

nonvolatile memory

PCIe

Peripheral Component Interconnect Express

POST

Power-On Self Test

PSU

power supply unit

RBSU

ROM-Based Setup Utility

SAS

serial attached SCSI

SATA

serial ATA

SD

Secure Digital

SPP

HP Service Pack for ProLiant

SSD

solid-state drive

TDP

Thermal Design Power

TPM

Trusted Platform Module

USB

universal serial bus

xHCI

Extensible Host Controller Interface

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